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LED LCD TV SERVICE MANUAL

CHASSIS : LD2AB

MODEL : 26LT360C 26LT360C-ZA

CAUTION

BEFORE SERVICING THE CHASSIS,
READ THE SAFETY PRECAUTIONS IN THIS MANUAL.



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SAFETY PRECAUTIONS

IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by \triangle in the Schematic Diagram and Exploded View.

It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent Shock, Fire, or other Hazards.

Do not modify the original design without permission of manufacturer.

General Guidance

An **isolation Transformer should always be used** during the servicing of a receiver whose chassis is not isolated from the AC power line. Use a transformer of adequate power rating as this protects the technician from accidents resulting in personal injury from electrical shocks.

It will also protect the receiver and its components from being damaged by accidental shorts of the circuitry that may be inadvertently introduced during the service operation.

If any fuse (or Fusible Resistor) in this TV receiver is blown, replace it with the specified.

When replacing a high wattage resistor (Oxide Metal Film Resistor, over 1 W), keep the resistor 10 mm away from PCB.

Keep wires away from high voltage or high temperature parts.

Before returning the receiver to the customer,

always perform an **AC leakage current check** on the exposed metallic parts of the cabinet, such as antennas, terminals, etc., to be sure the set is safe to operate without damage of electrical shock.

Leakage Current Cold Check(Antenna Cold Check)

With the instrument AC plug removed from AC source, connect an electrical jumper across the two AC plug prongs. Place the AC switch in the on position, connect one lead of ohm-meter to the AC plug prongs tied together and touch other ohm-meter lead in turn to each exposed metallic parts such as antenna terminals, phone jacks, etc.

If the exposed metallic part has a return path to the chassis, the measured resistance should be between 1 M Ω and 5.2 M Ω .

When the exposed metal has no return path to the chassis the reading must be infinite.

An other abnormality exists that must be corrected before the receiver is returned to the customer.

Leakage Current Hot Check (See below Figure)

Plug the AC cord directly into the AC outlet.

Do not use a line Isolation Transformer during this check.

Connect 1.5 K / 10 watt resistor in parallel with a 0.15 μ F capacitor between a known good earth ground (Water Pipe, Conduit, etc.) and the exposed metallic parts.

Measure the AC voltage across the resistor using AC voltmeter with 1000 ohms/volt or more sensitivity.

Reverse plug the AC cord into the AC outlet and repeat AC voltage measurements for each exposed metallic part. Any voltage measured must not exceed 0.75 volt RMS which corresponds to 0.5 mA.

In case any measurement is out of the limits specified, there is possibility of shock hazard and the set must be checked and repaired before it is returned to the customer.

Leakage Current Hot Check circuit



When 25A is impressed between Earth and 2nd Ground for 1 second, Resistance must be less than 0.1 Ω

*Base on Adjustment standard

SERVICING PRECAUTIONS

CAUTION: Before servicing receivers covered by this service manual and its supplements and addenda, read and follow the **SAFETY PRECAUTIONS** on page 3 of this publication.
NOTE: If unforeseen circumstances create conflict between the following servicing precautions and any of the safety precautions on page 3 of this publication, always follow the safety precautions. Remember: Safety First.

General Servicing Precautions

1. Always unplug the receiver AC power cord from the AC power source before;
 - a. Removing or reinstalling any component, circuit board module or any other receiver assembly.
 - b. Disconnecting or reconnecting any receiver electrical plug or other electrical connection.
 - c. Connecting a test substitute in parallel with an electrolytic capacitor in the receiver.**CAUTION:** A wrong part substitution or incorrect polarity installation of electrolytic capacitors may result in an explosion hazard.
2. Test high voltage only by measuring it with an appropriate high voltage meter or other voltage measuring device (DVM, FETVOM, etc) equipped with a suitable high voltage probe. Do not test high voltage by "drawing an arc".
3. Do not spray chemicals on or near this receiver or any of its assemblies.
4. Unless specified otherwise in this service manual, clean electrical contacts only by applying the following mixture to the contacts with a pipe cleaner, cotton-tipped stick or comparable non-abrasive applicator; 10 % (by volume) Acetone and 90 % (by volume) isopropyl alcohol (90 % - 99 % strength)
CAUTION: This is a flammable mixture.
Unless specified otherwise in this service manual, lubrication of contacts is not required.
5. Do not defeat any plug/socket B+ voltage interlocks with which receivers covered by this service manual might be equipped.
6. Do not apply AC power to this instrument and/or any of its electrical assemblies unless all solid-state device heat sinks are correctly installed.
7. Always connect the test receiver ground lead to the receiver chassis ground before connecting the test receiver positive lead.
Always remove the test receiver ground lead last.
8. Use with this receiver only the test fixtures specified in this service manual.
CAUTION: Do not connect the test fixture ground strap to any heat sink in this receiver.

Electrostatically Sensitive (ES) Devices

Some semiconductor (solid-state) devices can be damaged easily by static electricity. Such components commonly are called Electrostatically Sensitive (ES) Devices. Examples of typical ES devices are integrated circuits and some field-effect transistors and semiconductor "chip" components. The following techniques should be used to help reduce the incidence of component damage caused by static by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed to prevent potential shock reasons prior to applying power to the unit under test.

2. After removing an electrical assembly equipped with ES devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
3. Use only a grounded-tip soldering iron to solder or unsolder ES devices.
4. Use only an anti-static type solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ES devices.
5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ES devices.
6. Do not remove a replacement ES device from its protective package until immediately before you are ready to install it. (Most replacement ES devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive material).
7. Immediately before removing the protective material from the leads of a replacement ES device, touch the protective material to the chassis or circuit assembly into which the device will be installed.
CAUTION: Be sure no power is applied to the chassis or circuit, and observe all other safety precautions.
8. Minimize bodily motions when handling unpackaged replacement ES devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ES device.)

General Soldering Guidelines

1. Use a grounded-tip, low-wattage soldering iron and appropriate tip size and shape that will maintain tip temperature within the range of 500 °F to 600 °F.
2. Use an appropriate gauge of RMA resin-core solder composed of 60 parts tin/40 parts lead.
3. Keep the soldering iron tip clean and well tinned.
4. Thoroughly clean the surfaces to be soldered. Use a mall wire-bristle (0.5 inch, or 1.25 cm) brush with a metal handle. Do not use freon-propelled spray-on cleaners.
5. Use the following unsoldering technique
 - a. Allow the soldering iron tip to reach normal temperature. (500 °F to 600 °F)
 - b. Heat the component lead until the solder melts.
 - c. Quickly draw the melted solder with an anti-static, suction-type solder removal device or with solder braid.
CAUTION: Work quickly to avoid overheating the circuit board printed foil.
6. Use the following soldering technique.
 - a. Allow the soldering iron tip to reach a normal temperature (500 °F to 600 °F)
 - b. First, hold the soldering iron tip and solder the strand against the component lead until the solder melts.
 - c. Quickly move the soldering iron tip to the junction of the component lead and the printed circuit foil, and hold it there only until the solder flows onto and around both the component lead and the foil.
CAUTION: Work quickly to avoid overheating the circuit board printed foil.
 - d. Closely inspect the solder area and remove any excess or splashed solder with a small wire-bristle brush.

IC Remove/Replacement

Some chassis circuit boards have slotted holes (oblong) through which the IC leads are inserted and then bent flat against the circuit foil. When holes are the slotted type, the following technique should be used to remove and replace the IC. When working with boards using the familiar round hole, use the standard technique as outlined in paragraphs 5 and 6 above.

Removal

1. Desolder and straighten each IC lead in one operation by gently prying up on the lead with the soldering iron tip as the solder melts.
2. Draw away the melted solder with an anti-static suction-type solder removal device (or with solder braid) before removing the IC.

Replacement

1. Carefully insert the replacement IC in the circuit board.
2. Carefully bend each IC lead against the circuit foil pad and solder it.
3. Clean the soldered areas with a small wire-bristle brush. (It is not necessary to reapply acrylic coating to the areas).

"Small-Signal" Discrete Transistor

Removal/Replacement

1. Remove the defective transistor by clipping its leads as close as possible to the component body.
2. Bend into a "U" shape the end of each of three leads remaining on the circuit board.
3. Bend into a "U" shape the replacement transistor leads.
4. Connect the replacement transistor leads to the corresponding leads extending from the circuit board and crimp the "U" with long nose pliers to insure metal to metal contact then solder each connection.

Power Output, Transistor Device

Removal/Replacement

1. Heat and remove all solder from around the transistor leads.
2. Remove the heat sink mounting screw (if so equipped).
3. Carefully remove the transistor from the heat sink of the circuit board.
4. Insert new transistor in the circuit board.
5. Solder each transistor lead, and clip off excess lead.
6. Replace heat sink.

Diode Removal/Replacement

1. Remove defective diode by clipping its leads as close as possible to diode body.
2. Bend the two remaining leads perpendicular y to the circuit board.
3. Observing diode polarity, wrap each lead of the new diode around the corresponding lead on the circuit board.
4. Securely crimp each connection and solder it.
5. Inspect (on the circuit board copper side) the solder joints of the two "original" leads. If they are not shiny, reheat them and if necessary, apply additional solder.

Fuse and Conventional Resistor

Removal/Replacement

1. Clip each fuse or resistor lead at top of the circuit board hollow stake.
2. Securely crimp the leads of replacement component around notch at stake top.

3. Solder the connections.

CAUTION: Maintain original spacing between the replaced component and adjacent components and the circuit board to prevent excessive component temperatures.

Circuit Board Foil Repair

Excessive heat applied to the copper foil of any printed circuit board will weaken the adhesive that bonds the foil to the circuit board causing the foil to separate from or "lift-off" the board. The following guidelines and procedures should be followed whenever this condition is encountered.

At IC Connections

To repair a defective copper pattern at IC connections use the following procedure to install a jumper wire on the copper pattern side of the circuit board. (Use this technique only on IC connections).

1. Carefully remove the damaged copper pattern with a sharp knife. (Remove only as much copper as absolutely necessary).
2. Carefully scratch away the solder resist and acrylic coating (if used) from the end of the remaining copper pattern.
3. Bend a small "U" in one end of a small gauge jumper wire and carefully crimp it around the IC pin. Solder the IC connection.
4. Route the jumper wire along the path of the out-away copper pattern and let it overlap the previously scraped end of the good copper pattern. Solder the overlapped area and clip off any excess jumper wire.

At Other Connections

Use the following technique to repair the defective copper pattern at connections other than IC Pins. This technique involves the installation of a jumper wire on the component side of the circuit board.

1. Remove the defective copper pattern with a sharp knife. Remove at least 1/4 inch of copper, to ensure that a hazardous condition will not exist if the jumper wire opens.
2. Trace along the copper pattern from both sides of the pattern break and locate the nearest component that is directly connected to the affected copper pattern.
3. Connect insulated 20-gauge jumper wire from the lead of the nearest component on one side of the pattern break to the lead of the nearest component on the other side.

Carefully crimp and solder the connections.

CAUTION: Be sure the insulated jumper wire is dressed so the it does not touch components or sharp edges.

SPECIFICATION

NOTE : Specifications and others are subject to change without notice for improvement.

1. Application range

This specification is applied to the LCD TV used LD2AB chassis.

2. Requirement for Test

Each part is tested as below without special appointment.

- 1) Temperature: 25 °C ± 5 °C(77 °F ± 9 °F), CST: 40 °C ± 5 °C
- 2) Relative Humidity: 65 % ± 10 %
- 3) Power Voltage
 - : Standard input voltage (AC 100-240 V~, 50/60 Hz)
 - * Standard Voltage of each products is marked by models.
- 4) Specification and performance of each parts are followed each drawing and specification by part number in accordance with BOM.
- 5) The receiver must be operated for about 5 minutes prior to the adjustment.

3. Test method

- 1) Performance: LGE TV test method followed
- 2) Demanded other specification
 - Safety : CE, IEC specification
 - EMC : CE, IEC

4. Model General Specification

No.	Item	Specification	Remarks
1	Market	EU(PAL Market-36Countries)	DTV & Analog (Total 36 countries) DTV (MPEG2/4, DVB-T) : 36 countries UK/ Italy/ Germany/ France/ Spain/ Sweden/ Finland/ Netherlands/ Belgium/ Luxemburg/ Greece/ Denmark/ Czech/ Austria/ Hungary/ Swiss/ Croatia/ Turkey/Norway/ Slovenia/ Poland/ Ukraine/ Portugal/ Ireland/ Morocco/ Latvia/ Estonia/ Lithuania/ Rumania/ Bulgaria/ Russia/ Slovakia/ Bosnia/Serbia/ Albania/ Kazakhstan DTV (MPEG2/4, DVB-C): 11 countries Sweden/ Finland/ Austria/ Swiss/ Germany/ Netherlands/ Hungary/ Slovenia/ Norway/ Denmark/ Bulgaria
2.	Broadcasting system	1) PAL-BG 2) PAL-DK 3) SECAM L/L' 4) DVB-T//C	Programme coverage VHF: E2 to E12, UHF : E21 to E69 CATV : S1 to S20, HYPER : S21 to S47
3	Receiving system	Analog : Upper Heterodyne Digital : COFDM , QAM	► DVB-T - Guard Interval(Bitrate_Mbit/s) 1/4, 1/8, 1/16, 1/32 - Modulation : Code Rate QPSK : 1/2, 2/3, 3/4, 5/6, 7/8 16-QAM : 1/2, 2/3, 3/4, 5/6, 7/8 64-QAM : 1/2, 2/3, 3/4, 5/6, 7/8 ► DVB-C - Symbolrate : 4.0Msymbols/s to 7.2Msymbols/s - Modulation : 16QAM, 64-QAM, 128-QAM and 256-QAM
4	Scart Jack (1EA)	PAL, SECAM	Scart 1 Jack is Full scart and support RF-OUT(analog).
5	Component Input (1EA)	Y/Cb/Cr Y/Pb/Pr	Video only(side)

No.	Item	Specification	Remarks
6	RGB Input	RGB-PC	Analog(D-SUB 15PIN)
7	HDMI Input (3EA)	HDMI1-DTV/DVI HDMI2-DTV HDMI3-DTV	PC(HDMI version 1.3) Support HDCP The number of Input ports is different by model.
8	Audio Input (1EA)	RGB/DVI Audio	In case of the RGB/DVI Audio input,
9	SDPIF out (1EA)	SPDIF out	
10	USB (1EA)	EMF, DivX HD, For SVC (download)	JPEG, MP3, DivX HD
12	DVB	DVB-T	CI : UK, Finland, Denmark, Norway, Sweden, Russia, Spain, Ireland, Luxemburg, Belgium, Netherland CI+ : France(Canal+), Italy(DGTvi)
		DVB-C	CI : Switzerland, Austria, Slovenia, Hungary, Bulgaria CI+ : Switzerland(UPC,Cablecom), Netherland(Ziggo), Germany(KDG,CWB), Finland(labwise)
13	RS232C (1EA)	Interactive mode support	

5. Video resolutions (2D)

5.1. Component Input (Y, C_B/P_B, C_R/P_R)

No.	Resolution	H-freq(kHz)	V-freq(Hz)	Pixel clock(MHz)	Proposed
1	720*480	15.73	60.00	13.5135	SDTV ,DVD 480I
2	720*480	15.73	59.94	13.50	SDTV ,DVD 480I
3	720*480	31.50	60.00	27.027	SDTV 480P
4	720*480	31.47	59.94	27.00	SDTV 480P
5	1280*720	45.00	60.00	74.25	HDTV 720P
6	1280*720	44.96	59.94	74.176	HDTV 720P
7	1920*1080	33.75	60.00	74.25	HDTV 1080I
8	1920*1080	33.72	59.94	74.176	HDTV 1080I
9	1920*1080	67.50	60.00	148.50	HDTV 1080P
10	1920*1080	67.432	59.94	148.352	HDTV 1080P
11	1920*1080	27.00	24.00	74.25	HDTV 1080P
12	1920*1080	26.97	23.94	74.176	HDTV 1080P
13	1920*1080	33.75	30.00	74.25	HDTV 1080P
14	1920*1080	33.71	29.97	74.176	HDTV 1080P

5.2. RGB Input (PC)

No.	Resolution	H-freq(kHz)	V-freq.(Hz)	Pixel clock(MHz)	Proposed	DDC
1	640*350	31.468	70.09	25.17	EGA	X
2	720*400	31.469	70.08	28.32	DOS	O
3	640*480	31.469	59.94	25.17	VESA(VGA)	O
4	800*600	37.879	60.31	40.00	VESA(SVGA)	O
5	1024*768	48.363	60.00	65.00	VESA(XGA)	O
6	1280*768	47.776	59.870	79.50	CVT(WXGA)	X
7	1360*768	47.712	60.015	85.50	VESA (WXGA)	X
8	1280*1024	63.981	60.020	108.0	VESA (SXGA)	O
9	1600*1200	75.00	60.00	162.0	VESA (UXGA)	X
10	1920*1080	66.587	59.934	138.5	HDTV 1080P	O

5.3. HDMI Input(PC/DTV)

No.	Resolution	H-freq(kHz)	V-freq.(Hz)	Pixel clock(MHz)	Proposed		Remark
PC(DVI)					DDC		
1	640*350	31.468	70.09	25.17	EGA	X	
2	720*400	31.469	70.08	28.32	DOS	O	
3	640*480	31.469	59.94	25.17	VESA(VGA)	O	
4	800*600	37.879	60.31	40.00	VESA(SVGA)	O	
5	1024*768	48.363	60.00	65.00	VESA(XGA)	O	
6	1280*768	47.776	59.870	79.50	CVT(WXGA)	X	
7	1360*768	47.712	60.015	85.50	VESA (WXGA)	O	
8	1280*1024	63.981	60.020	108.0	VESA (SXGA)	O	
9	1600*1200	75.00	60.00	162.0	VESA (UXGA)	X	
10	1920*1080	67.50	60.00	148.5	HDTV 1080P	O	
DTV							
1	720*480	31.50	60.00	27.027	SDTV 480P		
2	720*480	31.47	59.94	27.00	SDTV 480P		
3	1280*720	45.00	60.00	74.25	HDTV 720P		
4	1280*720	44.96	59.94	74.176	HDTV 720P		
5	1920*1080	33.75	60.00	74.25	HDTV 1080I		
6	1920*1080	33.72	59.94	74.176	HDTV 1080I		
7	1920*1080	67.50	60.00	148.50	HDTV 1080P		
8	1920*1080	67.432	59.94	148.352	HDTV 1080P		
9	1920*1080	27.00	24.00	74.25	HDTV 1080P		
10	1920*1080	26.97	23.976	74.176	HDTV 1080P		
11	1920*1080	33.75	30.00	74.25	HDTV 1080P		

ADJUSTMENT INSTRUCTION

1. Application Range

This specification sheet is applied to all of the LCD TV with LD2AB chassis.

2. Designation

- (1) The adjustment is according to the order which is designated and which must be followed, according to the plan which can be changed only on agreeing.
- (2) Power adjustment : Free Voltage.
- (3) Magnetic Field Condition: Nil.
- (4) Input signal Unit: Product Specification Standard.
- (5) Reserve after operation : Above 5 Minutes (Heat Run)
Temperature : at 25 °C ± 5 °C
Relative humidity : 65 ± 10 %
Input voltage : 220 V, 60 Hz
- (6) Adjustment equipments: Color Analyzer(CA-210 or CA-110), DDC Adjustment Jig, Service remote control.
- (7) Push the "IN STOP" key - For memory initialization.

Case1 : Software version up

1. After downloading S/W by USB , TV set will reboot automatically.
2. Push "In-stop" key.
3. Push "Power on" key.
4. Function inspection
5. After function inspection, Push "In-stop" key.

Case2 : Function check at the assembly line

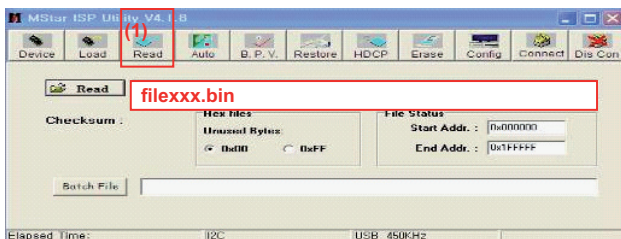
1. When TV set is entering on the assembly line, Push "In-stop" key at first.
2. Push "Power on" key for turning it on.
→ If you push "Power on" key, TV set will recover channel information by itself.
3. After function inspection, Push "In-stop" key.

3. Main PCB check process

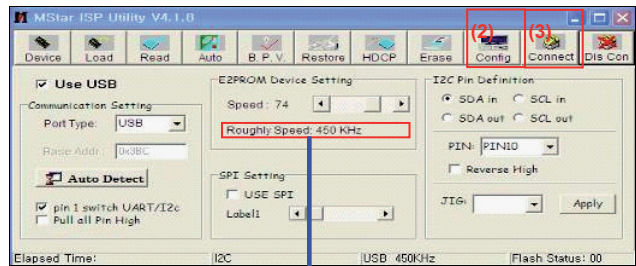
- APC - After Manual-Insert, executing APC

* Boot file Download

- (1) Execute ISP program "Mstar ISP Utility" and then click "Config" tab.
- (2) Set as below, and then click "Auto Detect" and check "OK" message.
If "Error" is displayed, check connection between computer, jig, and set.
- (3) Click "Read" tab, and then load download file(XXXX.bin) by clicking "Read"

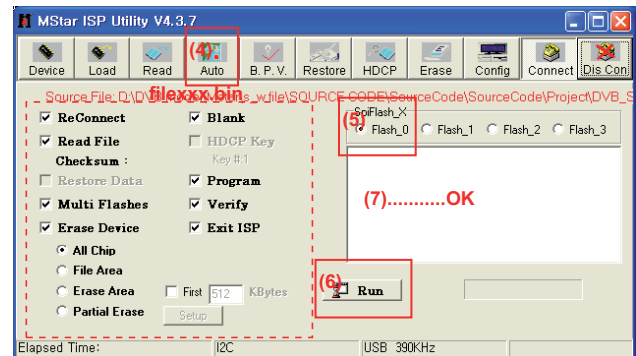


- (4) Click "Connect" tab. If "Can't" is displayed, check connection between computer, jig, and set.



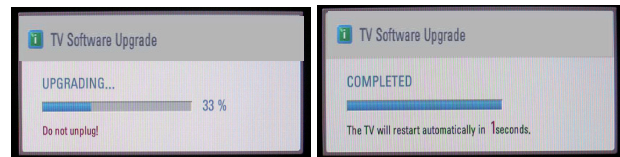
Please Check the Speed :
To use speed between
from 200KHz to 400KHz

- (5) Click "Auto" tab and set as below.
- (6) Click "Run".
- (7) After downloading, check "OK" message.



* USB DOWNLOAD

- (1) Put the USB Stick to the USB socket.
- (2) Automatically detecting update file in USB Stick.
- If your downloaded program version in USB Stick is Low, it didn't work. But your downloaded version is High, USB data is automatically detecting.
- (3) Show the message "Copying files from memory".
- (4) Updating is starting.



- (5) Updating Completed, The TV will restart automatically.
- (6) If your TV is turned on, check your updated version and Tool option. (explain the Tool option, next stage)

* If downloading version is more high than your TV have, TV can lost all channel data. In this case, you have to channel recover. if all channel data is cleared, you didn't have a DTV/ATV test on production line.

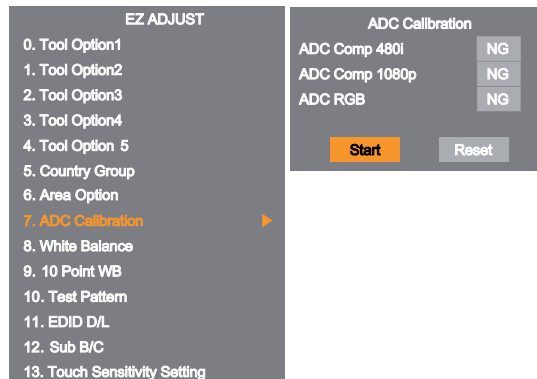
* After downloading, have to adjust Tool Option again.

- (1) Push "IN-START" key in service remote control.
- (2) Select "Tool Option 1" and push "OK" key.
- (3) Punch in the number. (Each model has their number)

3.1. ADC Process

(1) ADC

- Enter Service Mode by pushing "ADJ" key,
- Enter Internal ADC mode by pushing "▶" key at "7. ADC Calibration".



<Caution> Using "P-ONLY" key of the Adjustment remote control, power on TV.

If there is no Component Input, disappear "ADC Comp" message.

* ADC Calibration Protocol (RS232)

NO	Item	CMD 1	CMD 2	Data 0	
Enter Adjust MODE	Adjust 'Mode In'	A	A	0 0	When transfer the 'Mode In', Carry the command.
ADC adjust	ADC Adjust	A	D	1 0	Automatically adjustment (The use of a internal pattern)

Adjust Sequence

- aa 00 00 [Enter Adjust Mode]
 - xb 00 40 [Component1 Input (480i)]
 - ad 00 10 [Adjust 480i Comp1]
 - xb 00 60 [RGB Input (1024*768)] (only LD21B)
 - ad 00 10 [Adjust 1024*768 RGB] (only LD21B)
 - aa 00 90 End Adjust mode
- * Required equipment : Adjustment remote control.

3.2. Function Check

3.2.1. Check display and sound

- Check Input and Signal items. (cf. work instructions)

1. TV
2. AV
3. COMPONENT (480i)
4. RGB (PC : 1024 x 768 @ 60hz)
5. HDMI
6. PC Audio In

* Display and Sound check is executed by Remote controller

Caution : Not to push the INSTOP KEY after completion if the function inspection.

4. Total Assembly line process

4.1. Adjustment Preparation

- W/B Equipment condition
CA210
: CCFL/EEFL -> CH9, Test signal: Inner pattern(80IRE)
LED -> CH14, Test signal: Inner pattern(80IRE)
- Above 5 minutes H/run in the inner pattern. ("power on" key of adjust remote control)

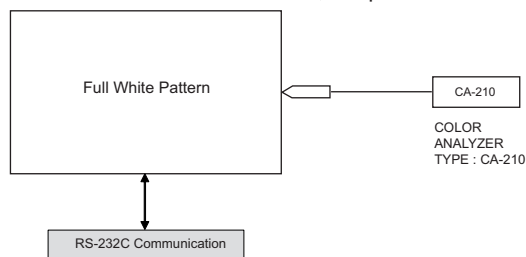
Mode	Temp	Coordinate spec	Target	
Cool	13,000k	X=0.269 (±0.002) Y=0.273 (±0.002)	X=0.271 Y=0.276	<Test Signal> Inner pattern (204gray, 80IRE)
Medium	9,300k	X=0.285 (±0.002) Y=0.293 (±0.002)	X=0.287 Y=0.296	
Warm	6,500k	X=0.313 (±0.002) Y=0.329 (±0.002)	X=0.315 Y=0.332	

- Edge LED W/B Table in process of aging time (Only LGD Edge LED Module except AUO, CMI, IPS Module)
CA210 : CH 14, Test signal : Inner pattern (80IRE)

GP4	Aging time (Min)	Cool		Medium		Warm	
		X	y	x	y	x	y
1	0-2	269	273	285	293	313	329
2	3-5	280	287	296	307	320	337
3	6-9	279	285	295	305	319	335
4	10-19	277	284	293	304	317	334
5	20-35	276	283	292	303	316	333
6	36-49	274	280	290	300	314	330
7	50-79	272	277	288	297	312	327
8	80-149	271	275	287	295	311	325
9	Over 150	270	274	286	294	310	324
		269	273	285	293	309	323

- * Connecting picture of the measuring instrument (On Automatic control)

Inside PATTERN is used when W/B is controlled. Connect to auto controller or push Adjustment R/C POWER ON → Enter the mode of White-Balance, the pattern will come out.



* Auto-control interface and directions

- (1) Adjust in the place where the influx of light like floodlight around is blocked. (illumination is less than 10 lux).
- (2) Adhere closely the Color analyzer(CA210) to the module less than 10 cm distance, keep it with the surface of the Module and Color analyzer's probe vertically.(80° ~ 100°).
- (3) Aging time
 - After aging start, keep the power on (no suspension of power supply) and heat-run over 5 minutes.
 - Using 'no signal' or 'POWER ONLY' or the others, check the back light on.

- Auto adjustment Map(using RS-232C to USB cable)

RS-232C COMMAND

[CMD ID DATA]

Wb 00 00 White Balance Start
Wb 00 ff White Balance End

	RS-232C COMMAND [CMD ID DATA]			MIN	CENTER (DEFAULT)			MAX
	Cool	Mid	Warm		Cool	Mid	Warm	
R Gain	jg	Ja	jd	00	172	192	192	192
G Gain	jh	Jb	je	00	172	192	192	192
B Gain	ji	Jc	jf	00	192	192	172	192
R Cut					64	64	64	128
G Cut					64	64	64	128
B Cut					64	64	64	128

<Caution>

Color Temperature : COOL, Medium, Warm.

One of R Gain/G Gain/ B Gain should be kept on 0xC0, and adjust other two lower than C0.(When R/G/B Gain are all C0, it is the FULL Dynamic Range of Module)

* Manual W/B process using adjust Remote control.

- After enter Service Mode by pushing "ADJ" key,
- Enter White Balance by pushing "►" key at "8. White Balance".

EZ ADJUST		White Balance	
0. Tool Option1		Color Temp.	◀ Cool ▶
1. Tool Option2		R-Gain	172
2. Tool Option3		G-Gain	172
3. Tool Option4		B-Gain	192
4. Tool Option5		R-Cut	64
5. Country Group		G-Cut	64
6. Area Option		B-Cut	64
7. ADC Calibration		Test-Pattern	ON
8. White Balance	▶	Backlight	100
9. 10 Point WB		Reset	To Set
10. Test Pattern			
11. EDID D/L			
12. Sub B/C			
13. Touch Sensitivity Setting			

- * After you finished all adjustments, Press "In-start" key and compare Tool option and Area option value with its BOM, if it is correctly same then unplug the AC cable. If it is not same, then correct it same with BOM and unplug AC cable. For correct it to the model's module from factory Jig model.

* Push the "IN STOP" key after completing the function inspection. And Mechanical Power Switch must be set "ON".

4.2. DDC EDID Write (RGB 128Byte)

- Connect D-sub Signal Cable to D-Sub Jack.
 - Write EDID DATA to EEPROM (24C02) by using DDC2B protocol.
 - Check whether written EDID data is correct or not.
- * For Service main Assembly, EDID have to be downloaded to Insert Process in advance.

4.3 DDC EDID Write (HDMI 256Byte)

- Connect HDMI Signal Cable to HDMI Jack.
 - Write EDID DATA to EEPROM(24C02) by using DDC2B protocol.
 - Check whether written EDID data is correct or not.
- * For Service main Assembly, EDID have to be downloaded to Insert Process in advance.

4.4. EDID data

(1) All Data : HEXA Value

(2) Changeable Data :

*: Serial No : Controlled / Data:01

**: Month : Controlled / Data:00

***:Year : Controlled

****:Check sum

4.4.1. Auto Download

- After enter Service Mode by pushing "ADJ" key,

- Enter EDID D/L mode.

- Enter "START" by pushing "OK" key.

* Caution : Never connect HDMI & D-sub Cable when EDID downloaded.

EZ ADJUST		EDID D/L	
0. Tool Option1		HDMI1	NG
1. Tool Option2		HDMI2	NG
2. Tool Option3		HDMI3	NG
3. Tool Option4		RGB	NG
4. Tool Option5			
5. Tool Option Commercial			
6. Country Group			
7. Area Option			
8. ADC Calibration			
9. White Balance			
10. 10 Point WB			
11. Test Pattern			
12 EDID D/L	▶	HDMI1	OK
13 Sub B/C		HDMI2	OK
14. Ext. Input Adjust		HDMI3	OK
		RGB	OK




* EDID data and Model option download (RS232)

NO	Item	CMD 1	CMD 2	Data 0	
Enter download MODE	Download 'Mode In'	A	A	0 0	When transfer the 'Mode In', Carry the command.
EDID data and Model option download	Download	A	E	00 10	Automatically download (The use of a internal data)

4.4.2. Manual Download

<Caution>

- (1) Use the proper signal cable for EDID Download
 - Analog EDID : Pin3 exists
 - Digital EDID : Pin3 exists
- (2) Never connect HDMI & D-sub Cable at the same time.
- (3) Use the proper cables below for EDID Writing.
- (4) Download HDMI1, HDMI2 separately because HDMI1 is different from HDMI2.

For Analog	For HDMI EDID	
D-sub to D-sub	DVI-D to HDMI or HDMI to HDMI	
		

No.	Item	Condition	Hex Data
1	Manufacturer ID	GSM	1E6D
2	Version	Digital : 1	01
3	Revision	Digital : 3	03

(1) HD RGB EDID data

	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
00	00	FF	FF	FF	FF	FF	FF	00	1E	6D	a				b	
10	c	01	03	68	A0	5A	78	0A	EE	91	A3	54	4C	99	26	
20	0F	50	54	A1	08	00	71	40	61	40	45	40	31	40	01	01
30	01	01	01	01	01	01	1B	21	50	A0	51	00	1E	30	48	88
40	35	00	40	84	00	00	00	1C	01	1D	00	72	51	D0	1E	20
50	6E	28	55	00	A0	5A	00	00	00	1E	00	00	00	FD	00	3A
60	3E	1E	53	10	00	0A	20	20	20	20	20	20			d	
70															00	e
80	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF
90	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF
A0	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF
B0	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF
C0	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF
D0	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF
E0	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF
F0	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF	FF

(2) HD HDMI EDID data

	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
00	00	FF	FF	FF	FF	FF	FF	00	1E	6D	a				b	
10	c	01	03	80	A0	5A	78	0A	EE	91	A3	54	4C	99	26	
20	0F	50	54	A1	08	00	31	40	45	40	61	40	71	40	01	01
30	01	01	01	01	01	01	66	21	50	B0	51	00	1B	30	40	70
40	36	00	40	84	63	00	00	1E	64	19	00	40	41	00	26	30
50	18	88	03	06	40	84	63	00	00	18	00	00	00	FD	00	3A
60	3E	1E	53	10	00	0A	20	20	20	20	20	20			d	
70															01	e
80	02	03	22	F1	4E	10	1F	04	93	05	14	03	02	12	20	21
90	22	15	01	26	15	07	50	09	57	07					f	
A0	80	1E	01	1D	80	18	71	1C	16	20	58	2C	25	00	A0	5A
B0	00	00	00	9E	01	1D	00	72	51	D0	1E	20	6E	28	55	00
C0	20	C2	31	00	00	1E	8C	0A	D0	8A	20	E0	2D	10	10	3E
D0	96	00	A0	5A	00	00	00	18	02	3A	80	18	71	38	2D	40
E0	58	2C	45	00	A0	5A	00	00	00	1E	00	00	00	00	00	00
F0	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	e

(3) Detail EDID Options are below

a. Product ID

MODEL NAME	HEX	EDID Table	DDC Function
HD/FHD Model	0001	01 00	Analog/Digital

b. Serial No: Controlled on production line.

c. Month, Year: Controlled on production line:

ex) Week : '01' -> '01'

Year : '2012' -> '16' fix

d. Model Name(Hex):

cf) TV set's model name in EDID data is below.

Model name	MODEL NAME(HEX)
LG TV	00 00 00 FC 00 4C 47 20 54 56 0A 20 20 20 20 20 20 (LG TV)

e. Checksum: Changeable by total EDID data.

EDID C/S data		HD	
		HDMI	RGB
Check sum (Hex)	Block 0	A4	A5
	Block 1	5B (HDMI1)	-
		4B (HDMI2)	
		3B (HDMI3)	

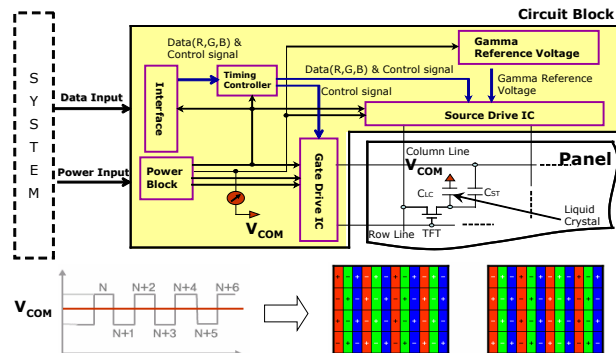
f. Vendor Specific(HDMI)

Input	Model name(HEX)
HDMI1	67030C001000
HDMI2	67030C002000
HDMI3	67030C003000

4.5. V-COM Adjust(Only LGD(M+S) Module)

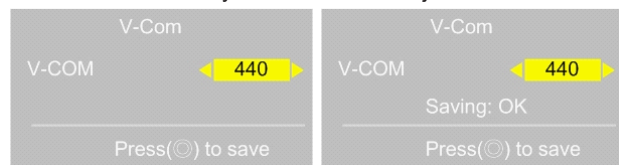
- Why need Vcom adjustment?

- The Vcom(Common Voltage) is a Reference Voltage of Liquid Crystal Driving. → Liquid Crystal need for Polarity Change with every frame.



- Adjust sequence

- Press the PIP key of the ADJ remote controller. (This PIP key is hot key to enter the VCOM adjusting mode)
- (Or After enter Service Mode by pushing "ADJ" key, then Enter V-Com Adjust mode by pushing "▶" key at "12. V-Com")
- As pushing the right or the left button on the remote controller, And find the V-COM value Which is no or minimized the Flicker. (If there is no flicker at default value, Press the exit key and finish the VCOM adjustment.)
- Push the OK key to store value. Then the message "Saving OK" is pop.
- Press the exit key to finish VCOM adjustment.



4.6. Outgoing condition Configuration

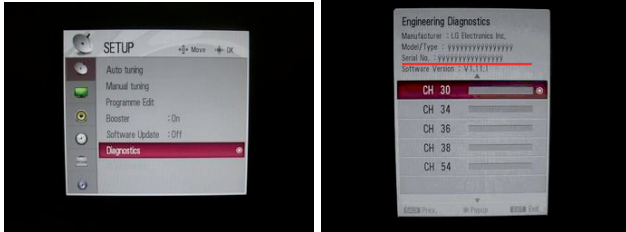
- When pressing IN-STOP key by SVC remocon, Red LED are blinked alternatively. And then automatically turn off. (Must not AC power OFF during blinking)

4.7. Hi-pot Test

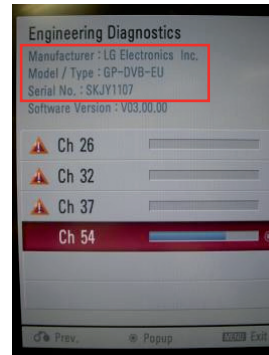
Confirm whether is normal or not when between power board's ac block and GND is impacted on 1.5 kV(dc) or 2.2 kV(dc) for one second

5. Model name & Serial number D/L

- Press "Power on" key of service remote control.
(Baud rate : 115200 bps)
- Connect RS232 Signal Cable to RS-232 Jack.
- Write Serial number by use RS-232.
- Must check the serial number at the Diagnostics of SET UP menu. (Refer to below).



- Check the model name Instart menu. → Factory name displayed.
(ex 42LD450-ZA)
- Check the Diagnostics.(DTV country only) → Buyer model displayed.(ex 42LD450)



5.1. Signal Table

CMD	LENGTH	ADH	ADL	DATA_1	...	Data_n	CS	DELAY
-----	--------	-----	-----	--------	-----	--------	----	-------

CMD : A0h
 LENGTH : 85~94h (1~16 bytes)
 ADH : EEPROM Sub Address high (00~1F)
 ADL : EEPROM Sub Address low (00~FF)
 Data : Write data
 CS : CMD + LENGTH + ADH + ADL + Data_1 +...+ Data_n
 Delay : 20ms

5.2. Comand Set

Adjust mode	CMD(hex)	LENGTH(hex)	Description
EEPROM WRITE	A0h	84h+n	n-bytes Write (n = 1~16)

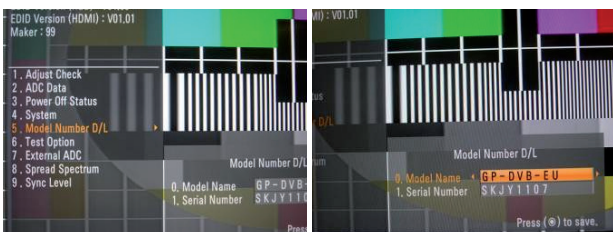
* Description
 FOS Default write : <7mode data> write
 Vtotal, V_Frequency, Sync_Polarity, Htotal, Hstart, Vstart, 0,
 Phase
 Data write : Model Name and Serial Number write in EEPROM,.

5.3. Method & notice

- Serial number D/L is using of scan equipment.
- Setting of scan equipment operated by Manufacturing Technology Group.
- Serial number D/L must be conformed when it is produced in production line, because serial number D/L is mandatory by D-book 4.0.

* Manual Download(Model Name and Serial Number)
 If the TV set is downloaded by OTA or Service man, sometimes model name or serial number is initialized.(Not always)
 There is impossible to download by bar code scan, so It need Manual download.

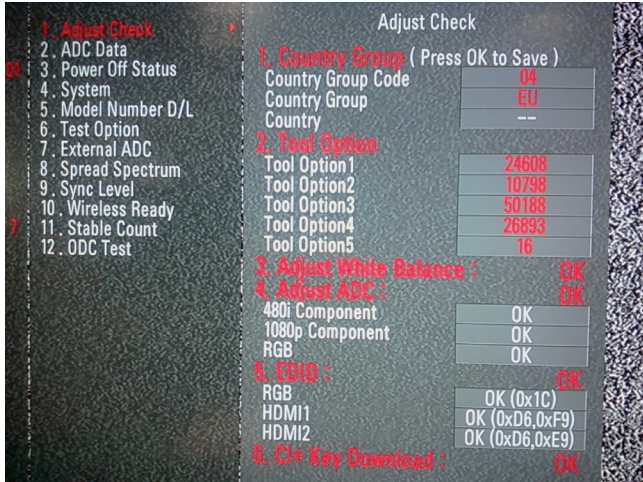
- Press the "Instart" key of Adjustment remote control.
- Go to the menu "5.Model Number D/L" like below photo.
- Input the Factory model name or Serial number like photo.



6. CI+ Key Download method

6.1. Download Procedure

- (1) Press "Power on" key of a service R/C.
(Baud rate : 115200 bps)
- (2) Connect RS232-C Signal Cable.
- (3) Write CI+ Key through RS-232-C.
- (4) Check whether the key was downloaded or not at 'In Start' menu. (Refer to below).



=> Check the Download to CI+ Key value in LGset.

1. Check the method of CI+ Key value
 - a. Check the method on Instart menu



- b. Check the method of RS232C Command

- 1) Into the main ass'y mode (RS232 : aa 00 00)

CMD 1	CMD 2	Data 0
A	A	0 0

- 2) Check the key download for transmitted command
(RS232 : ci 00 10)

CMD 1	CMD 2	Data 0
C	I	1 0

- 3) Result value

- Normally status for download : OKx
- Abnormally status for download : NGx

2. Check the method of CI+ key value (RS232)

- 1) Into the main ass'y mode (RS232 : aa 00 00)

CMD 1	CMD 2	Data 0
A	A	0 0

- 2) Check the method of CI+ key by command
(RS232 : ci 00 20)

CMD 1	CMD 2	Data 0
C	I	2 0

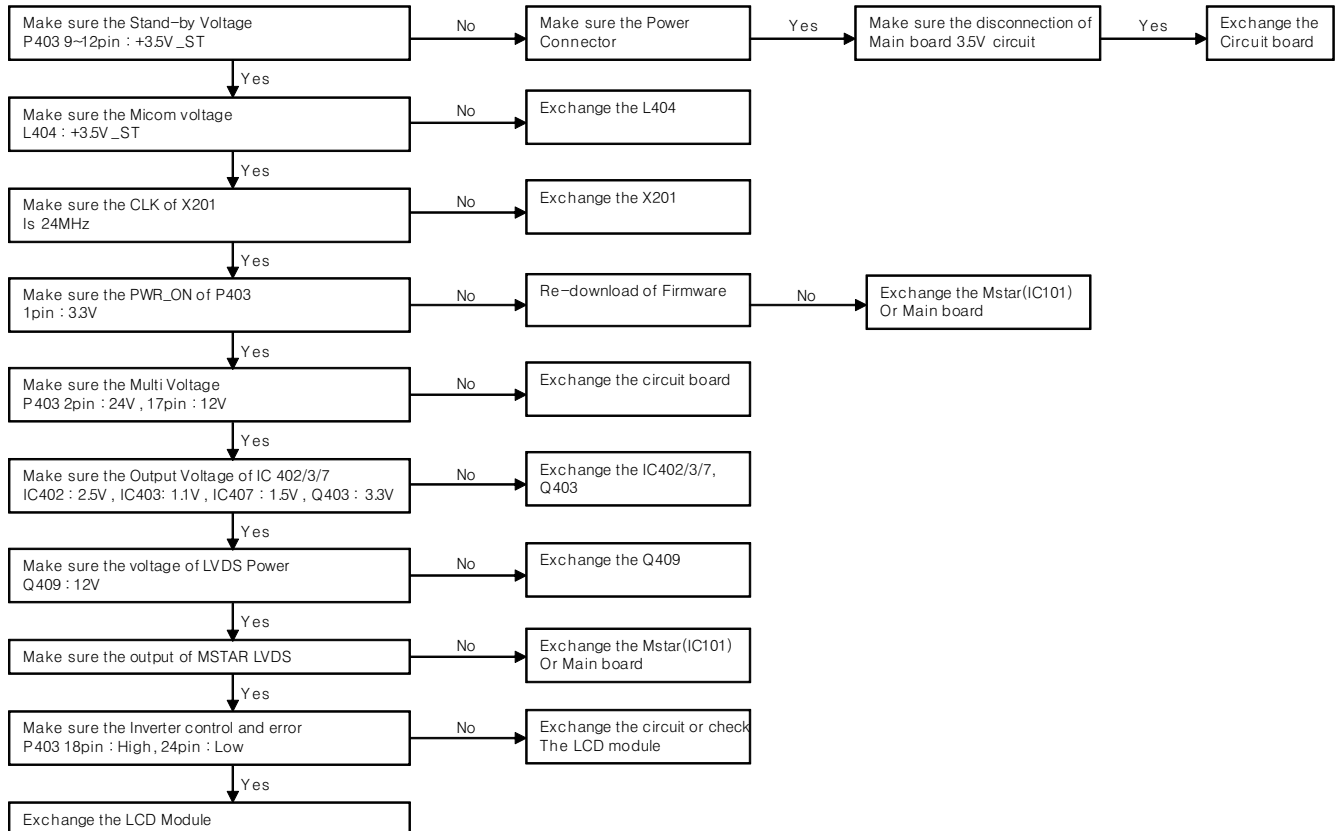
- 3) result value

i 01 OK 1d1852d21c1ed5dcx

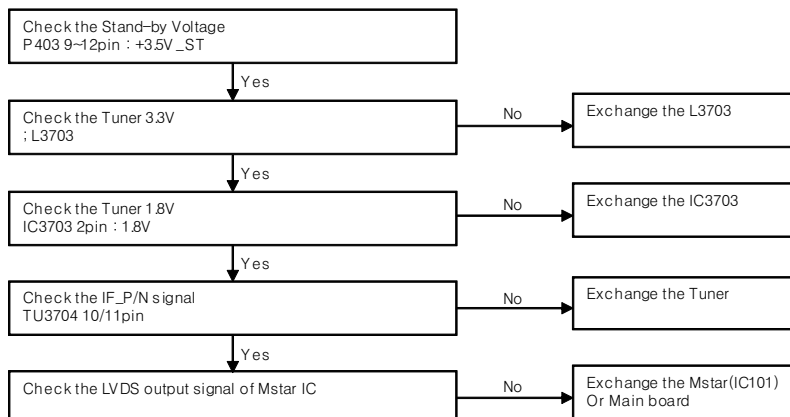
CI+ Key Value

TROUBLE SHOOTING

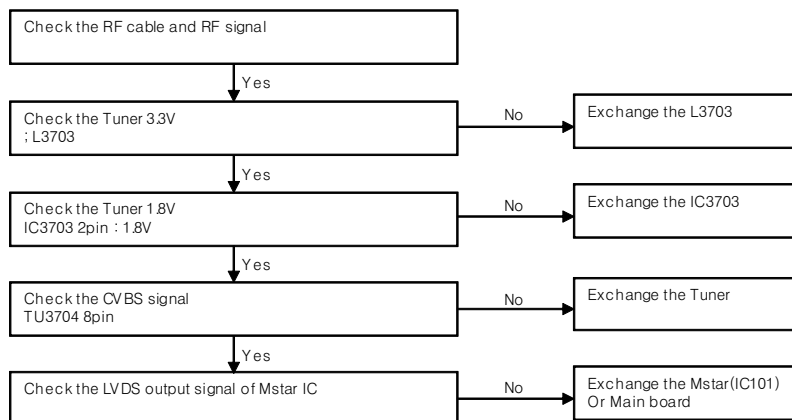
1. Check the booting Voltage



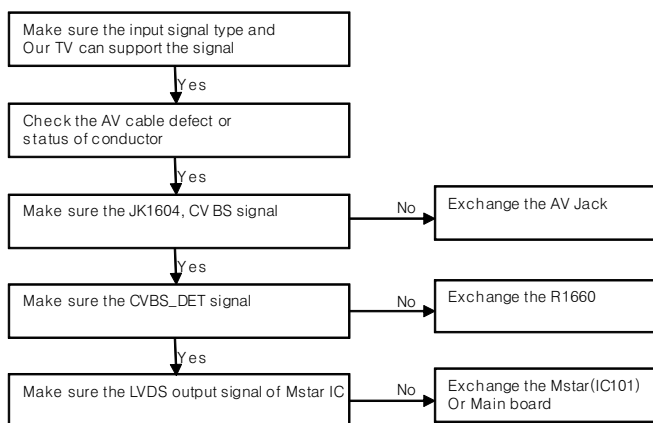
2. Digital TV Video



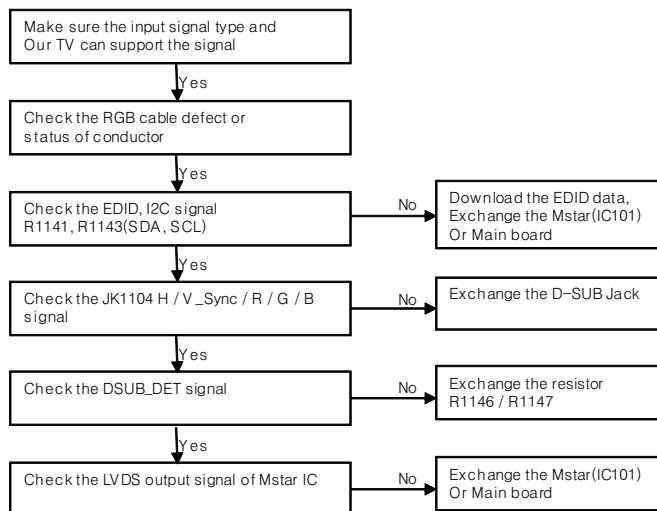
3. Analog TV Video



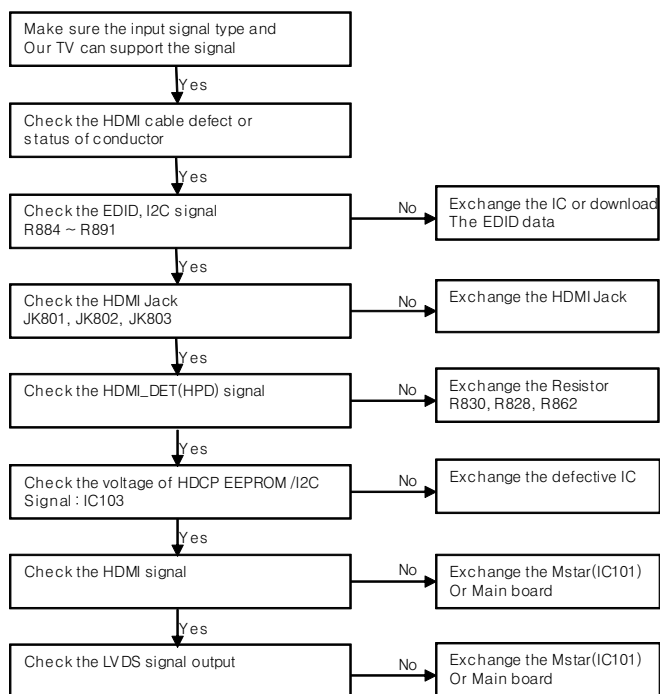
4. AV Video



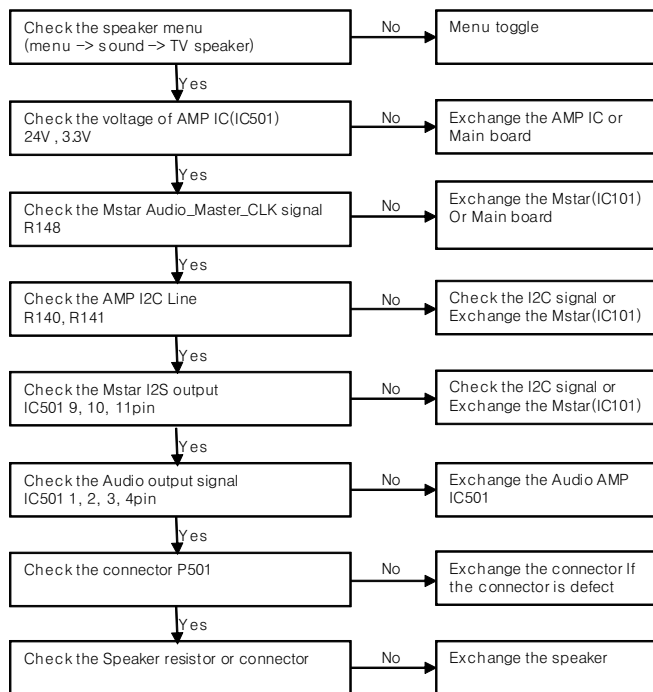
5. RGB Video



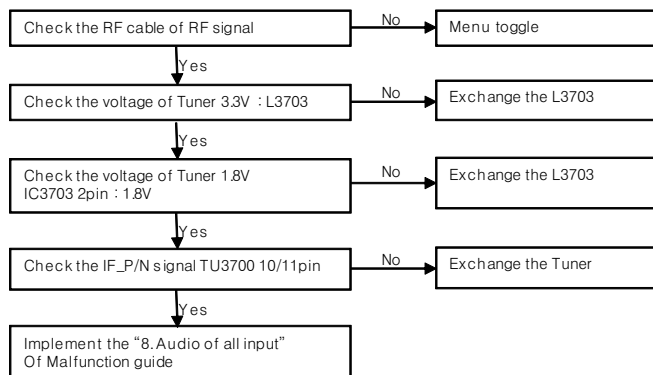
6. HDMI Video



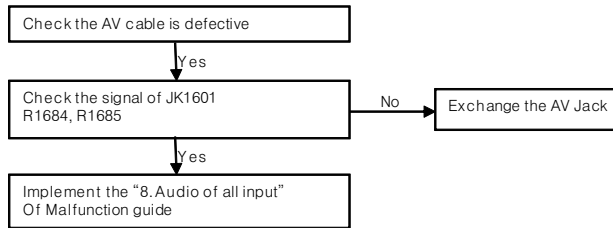
7. Audio of All input



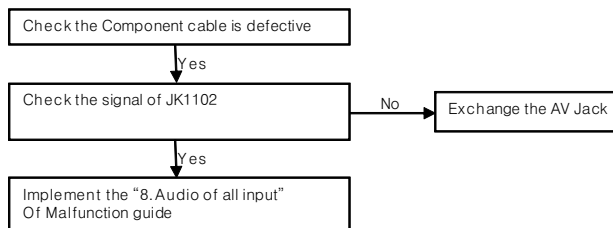
8. TV Audio



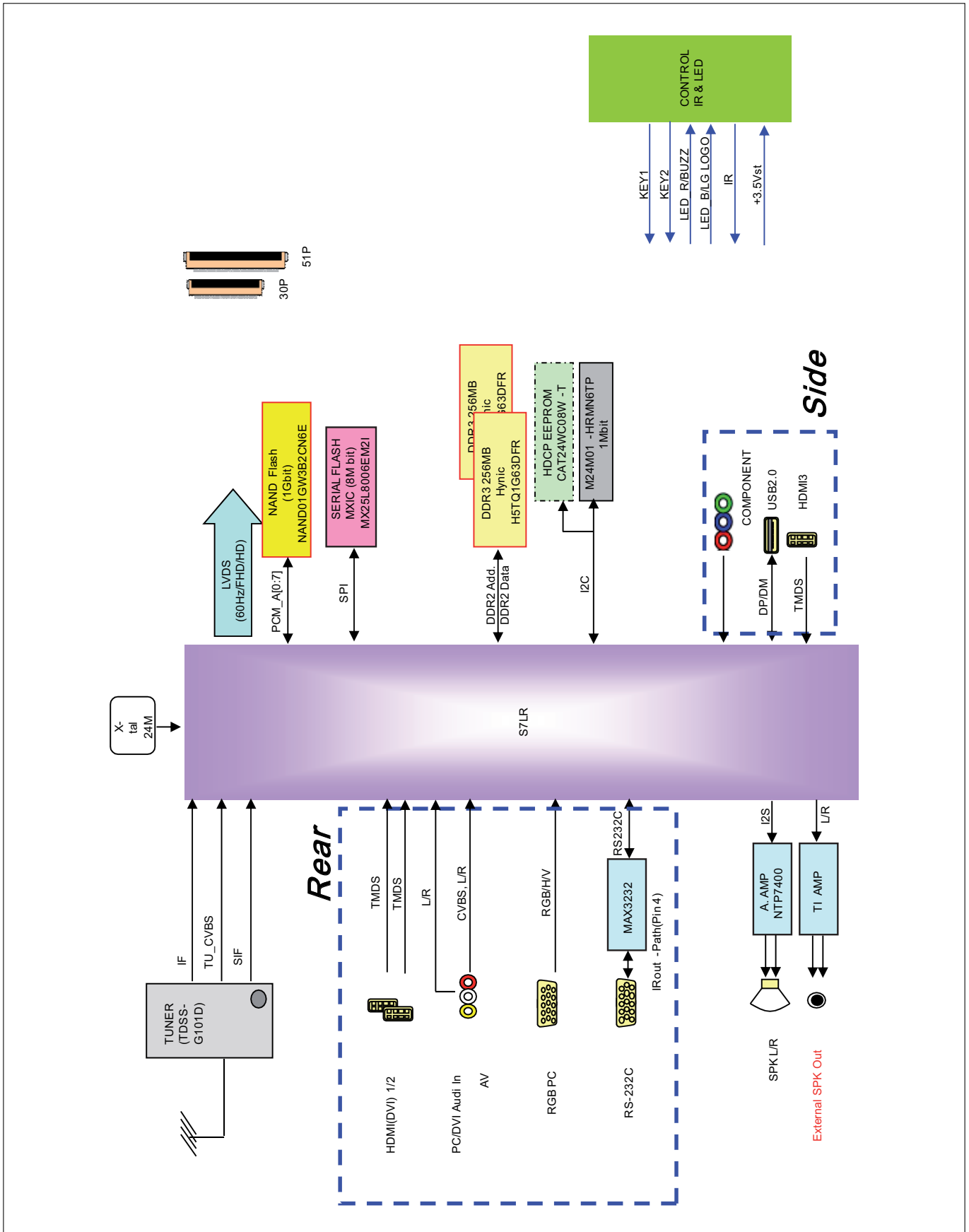
9. AV Audio



10. RGB Audio



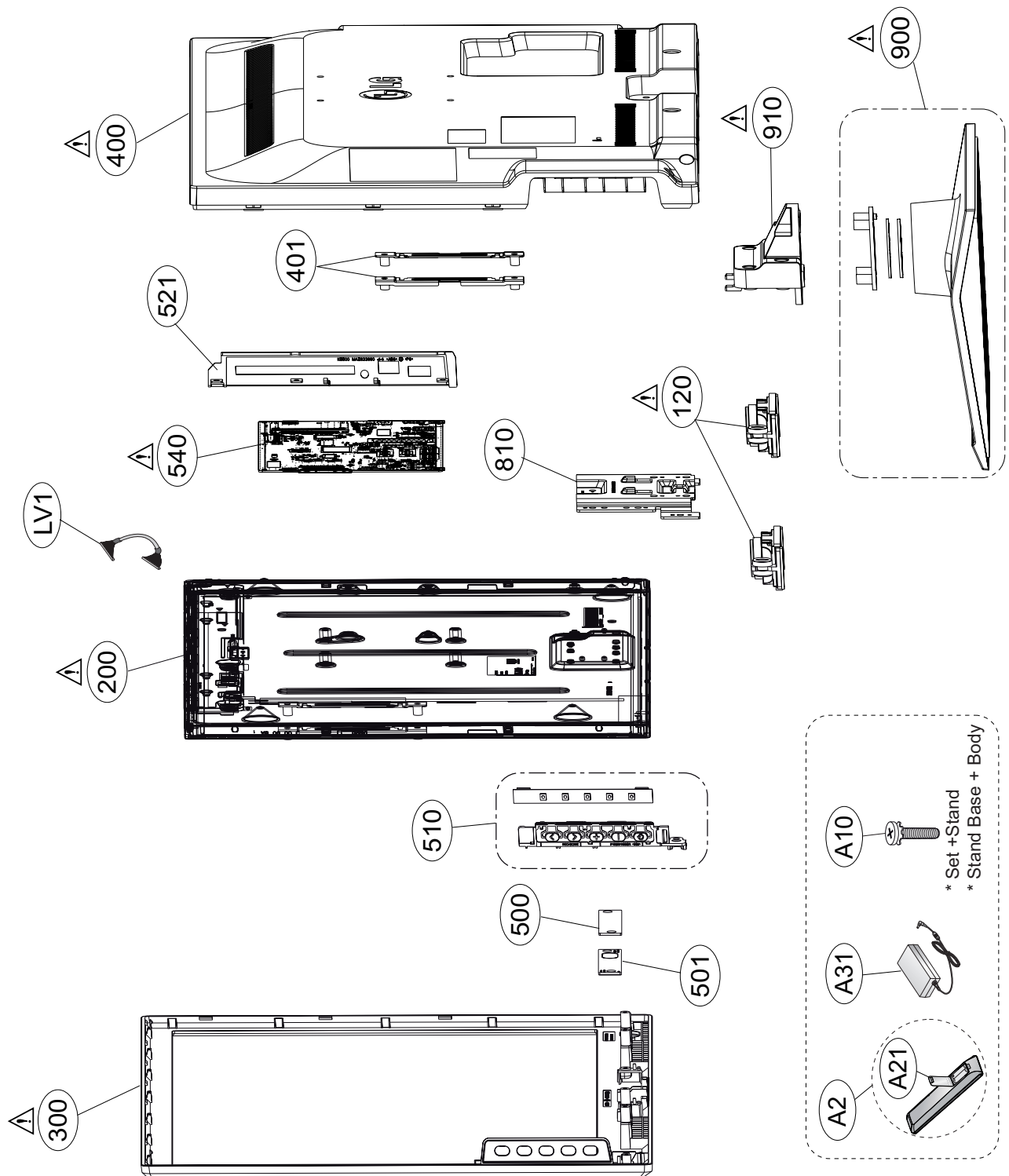
BLOCK DIAGRAM

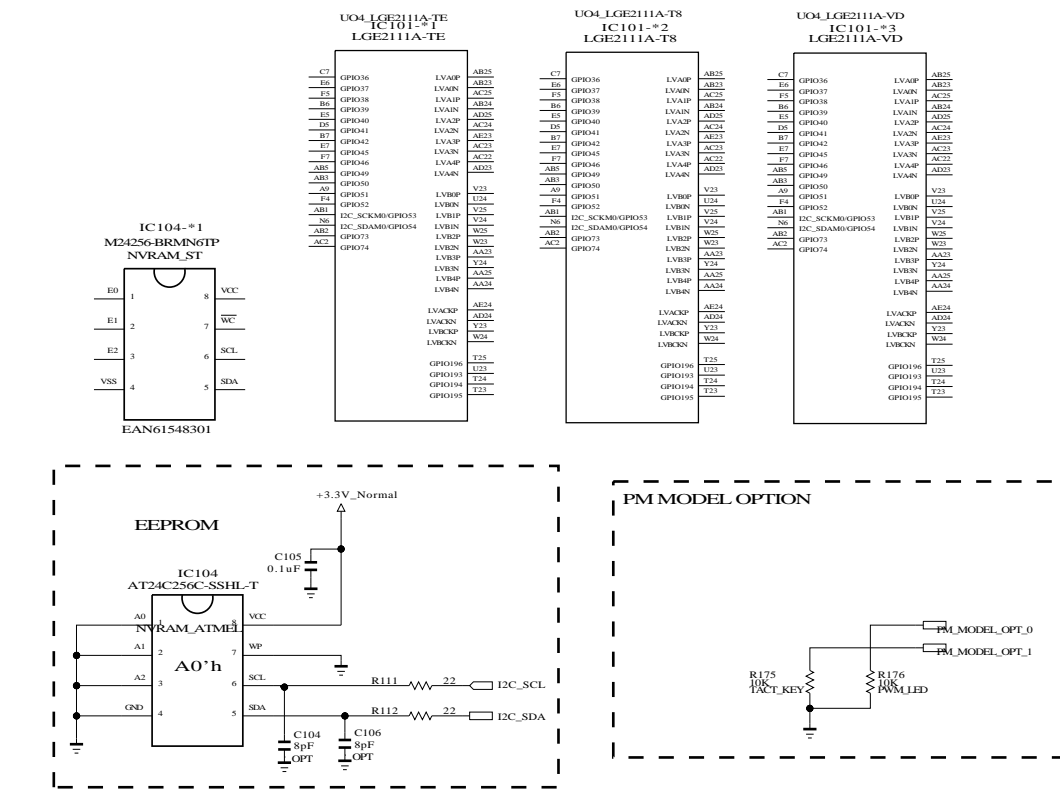
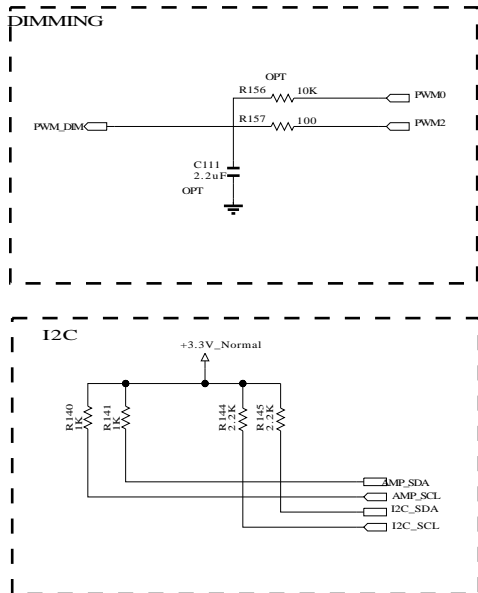
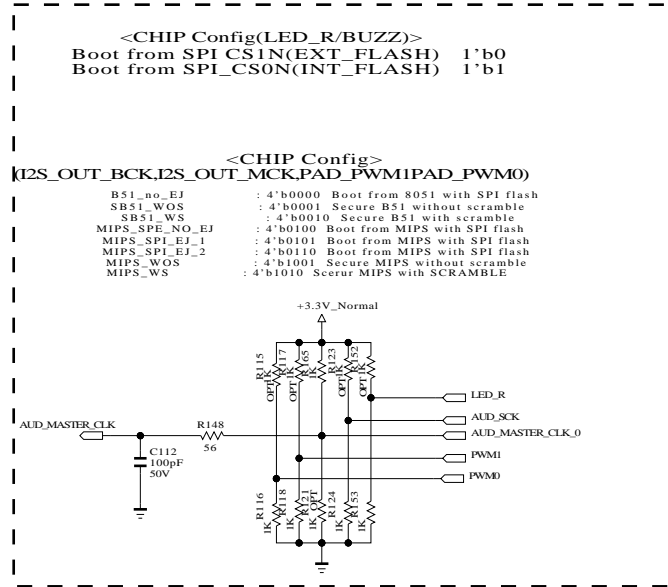


EXPLODED VIEW

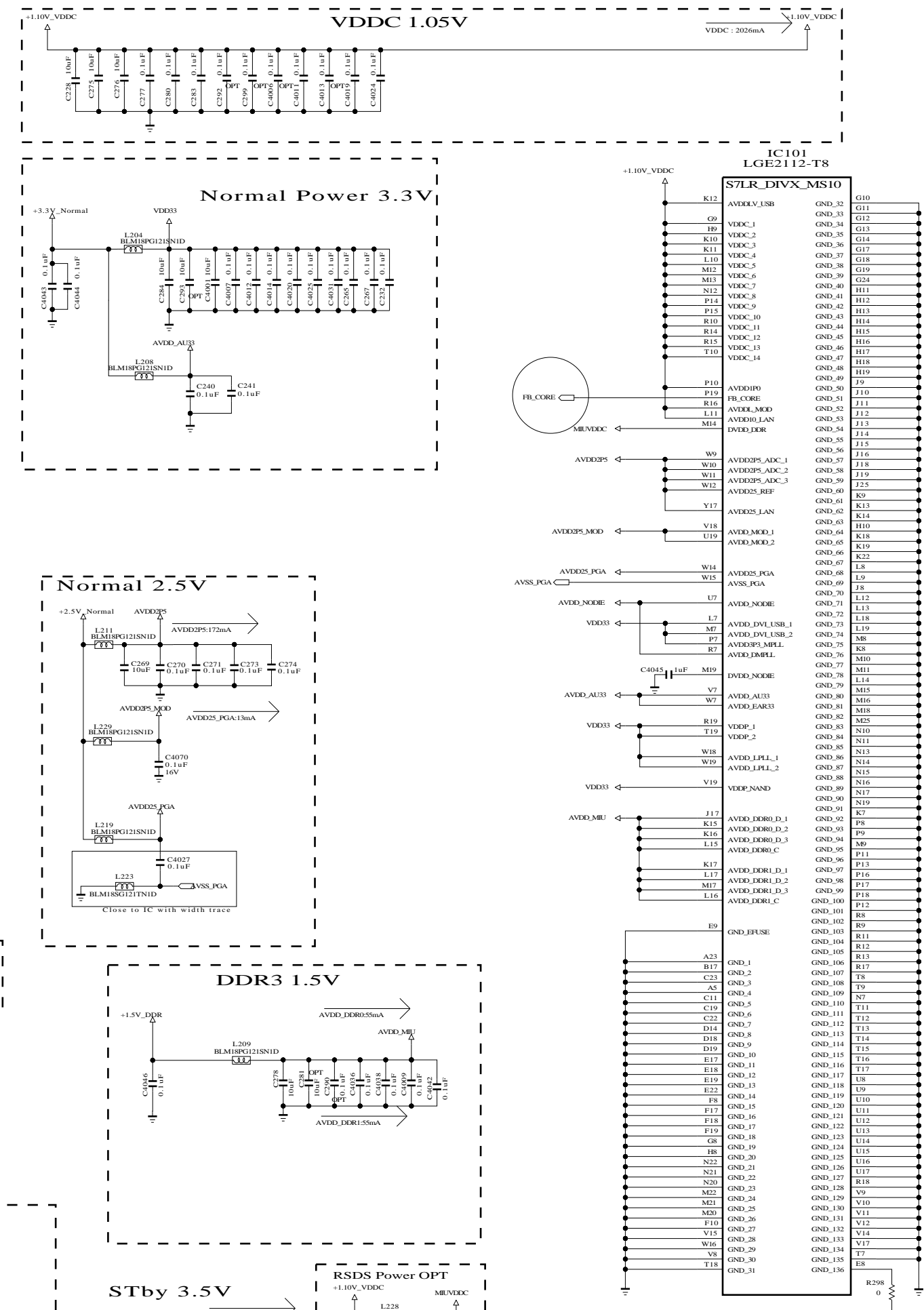
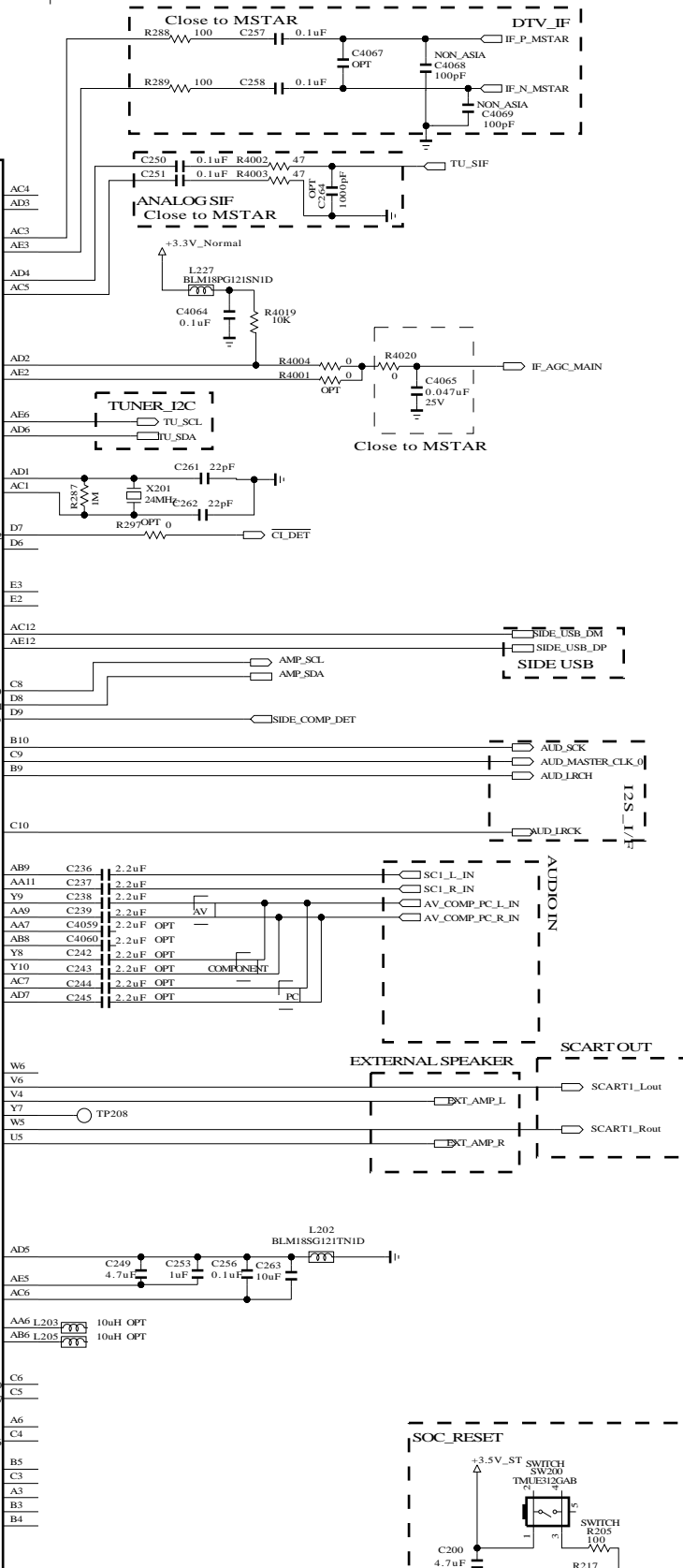
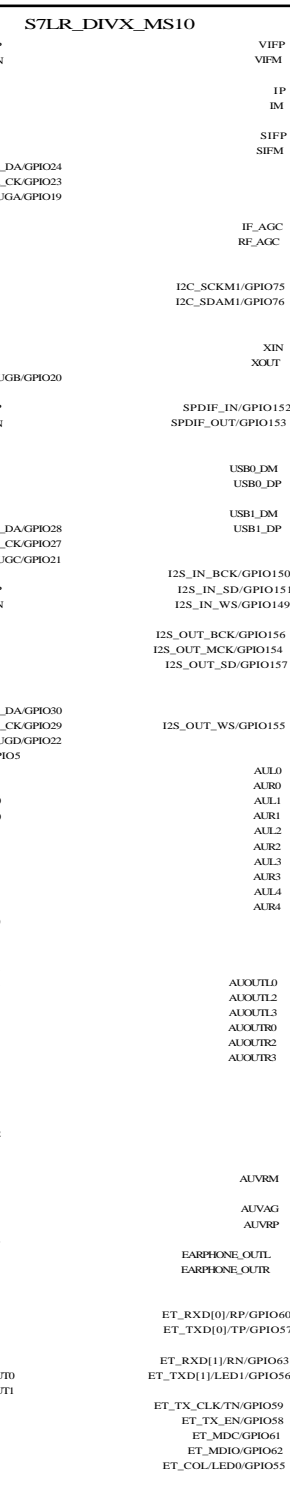
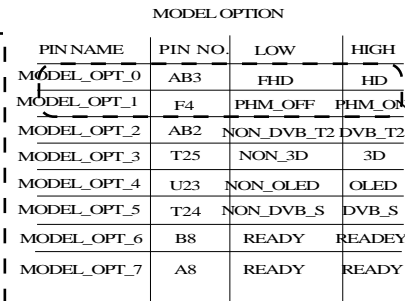
IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by ⚠ in the Schematic Diagram and EXPLODED VIEW. It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent X-RADIATION, Shock, Fire, or other Hazards. Do not modify the original design without permission of manufacturer.





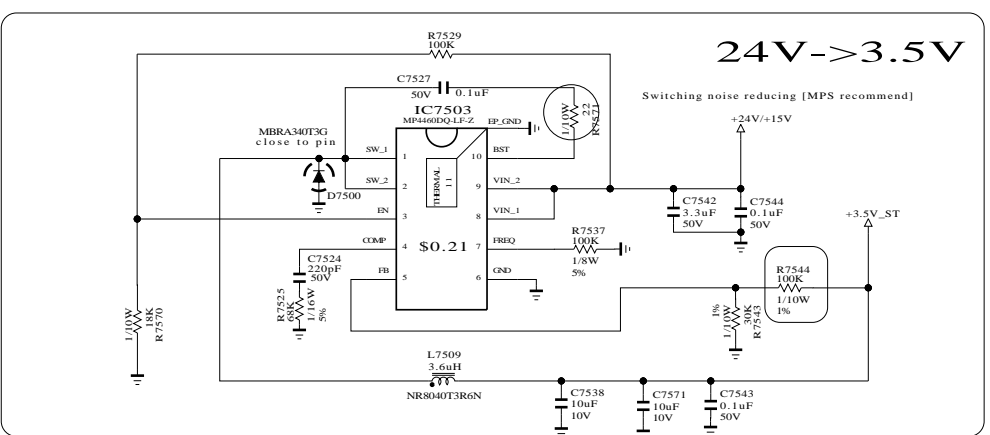
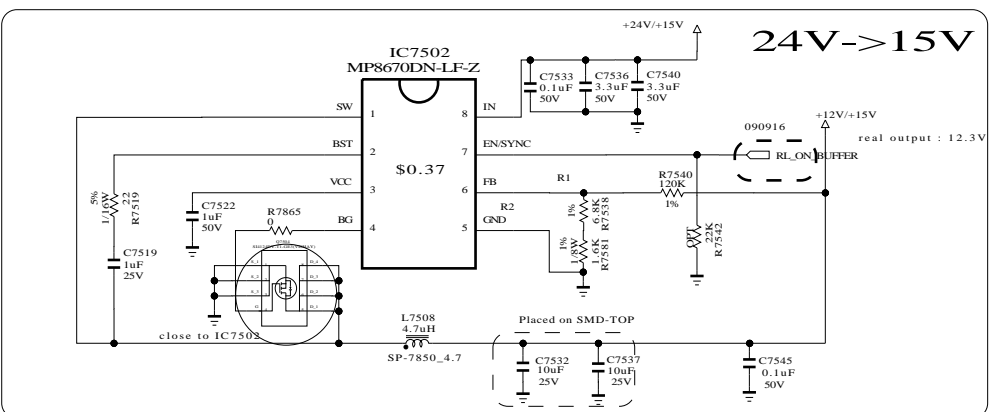
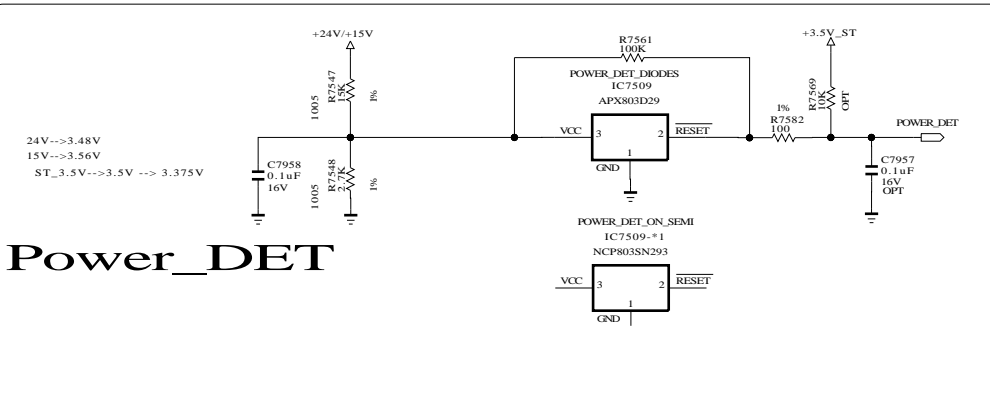
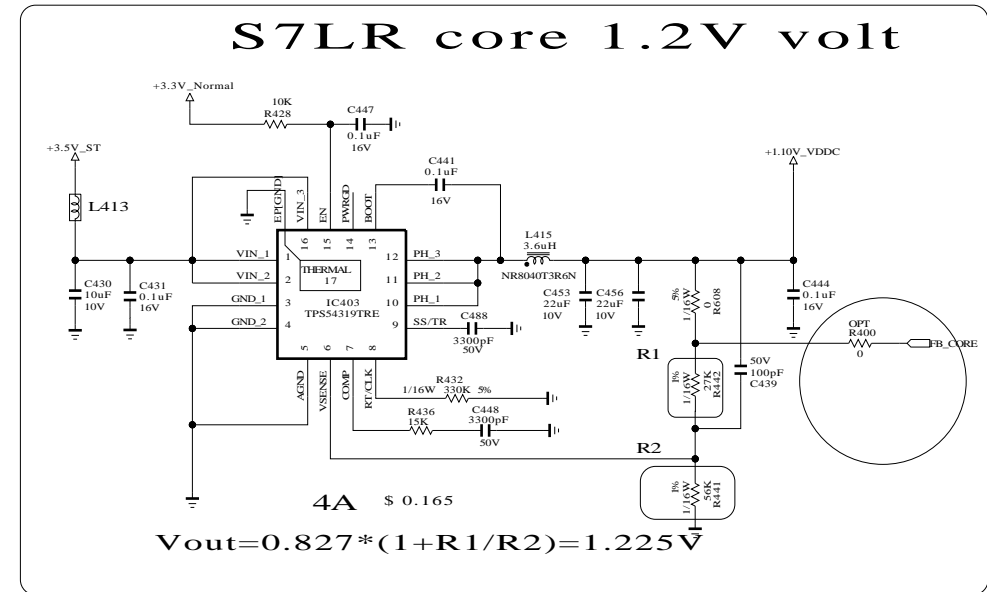
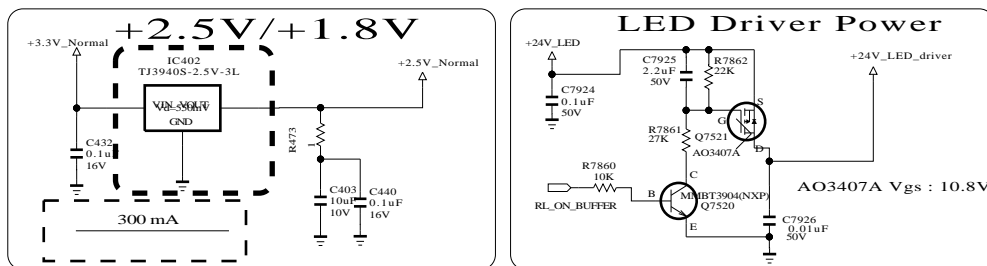
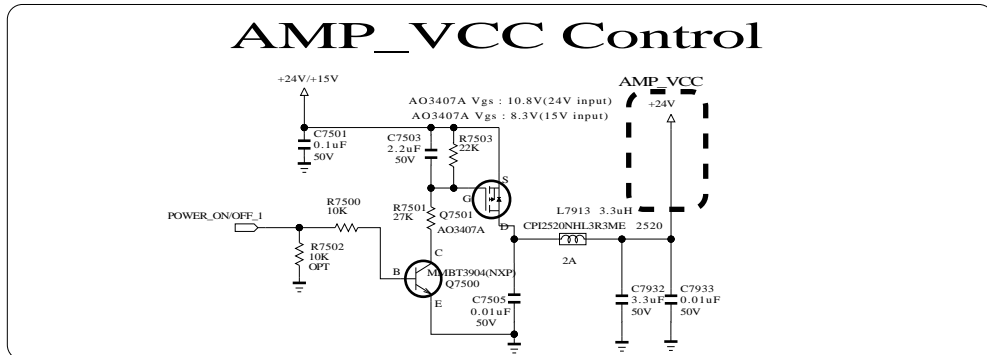
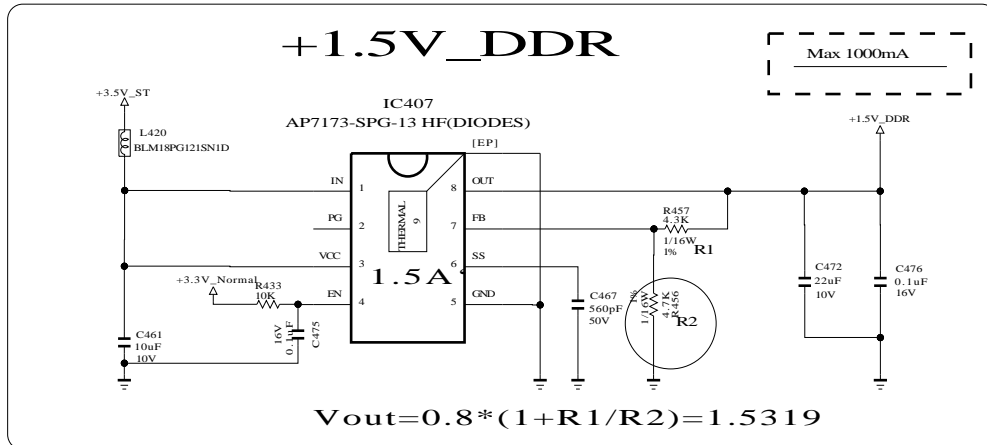
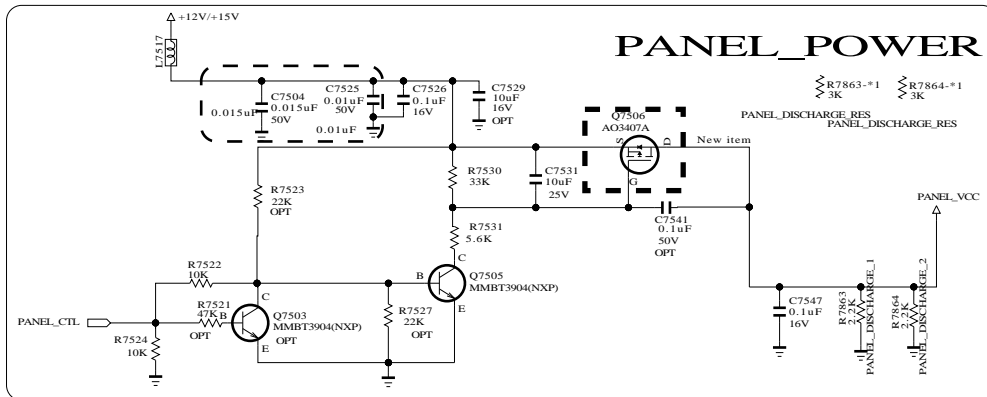
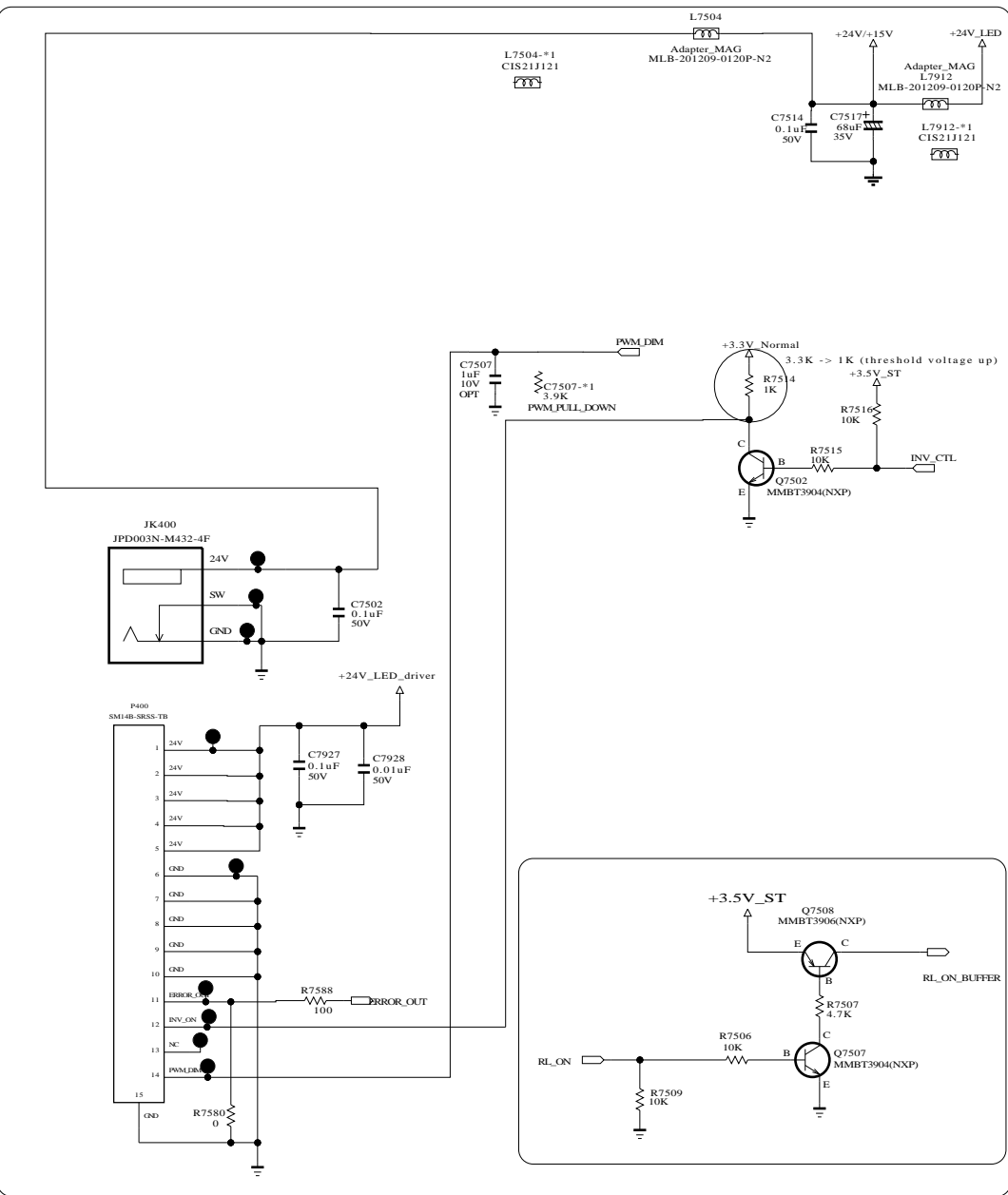
LGE Internal Use Only



SECRET
LGElectronics



MODEL	GP3_S7LR	DATE	20110511
BLOCK	MAIN2, HW OPT	SHEET	2 /



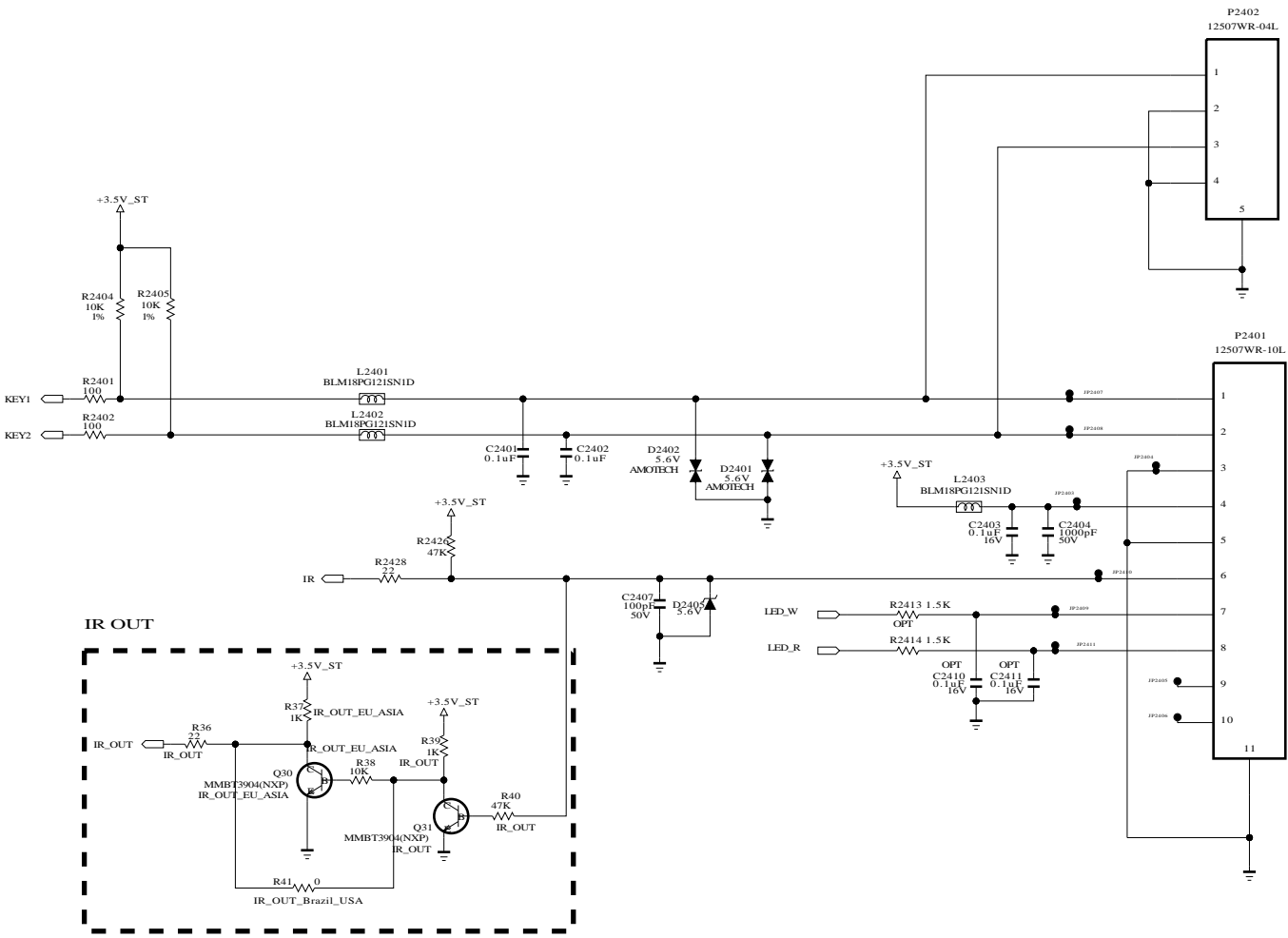
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.



SECRET
LGElectronics

LG ELECTRONICS

MODEL	S7LR_26LED	DATE	20110324
BLOCK	POWER_Adaptor	SHEET	4 /

CONTROL
IR & LED

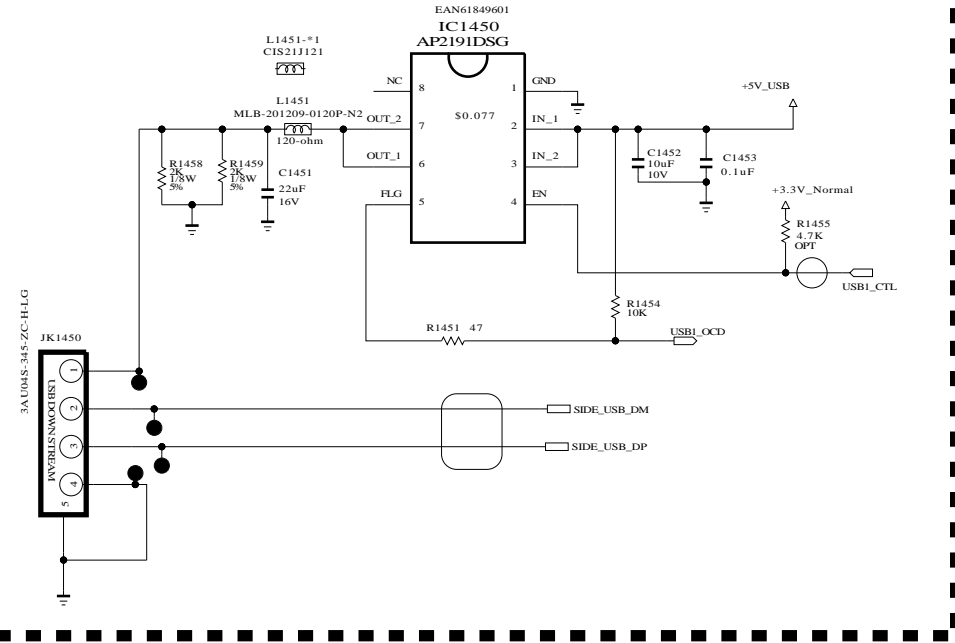




THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMETIC.

SECRET	 LG ELECTRONICS
LGElectronics	

MODEL	GP3_S7LR	DATE	20110324
BLOCK	IR/CONTROL-L	SHEET	6 /

USB_DIODES



THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

SECRET
LGElectronics



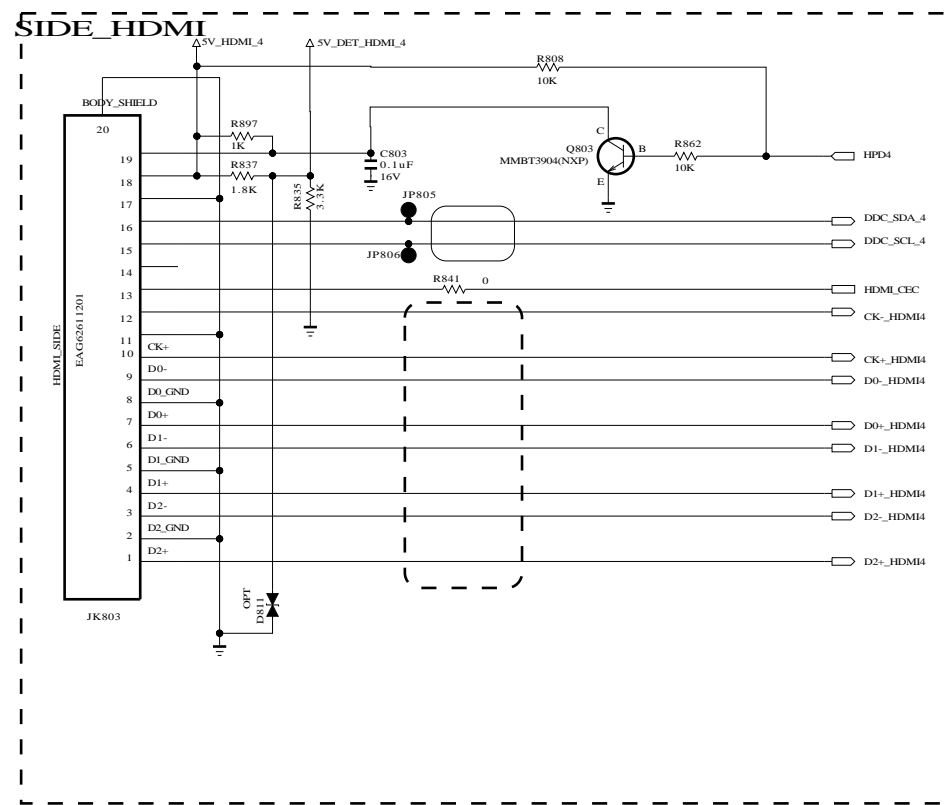
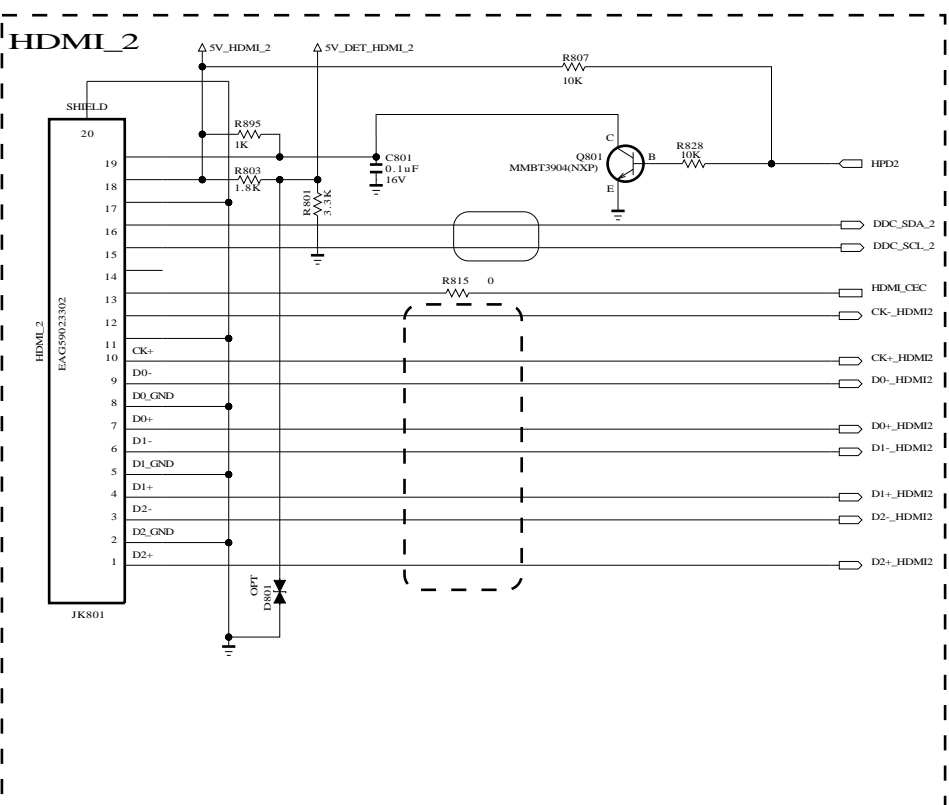
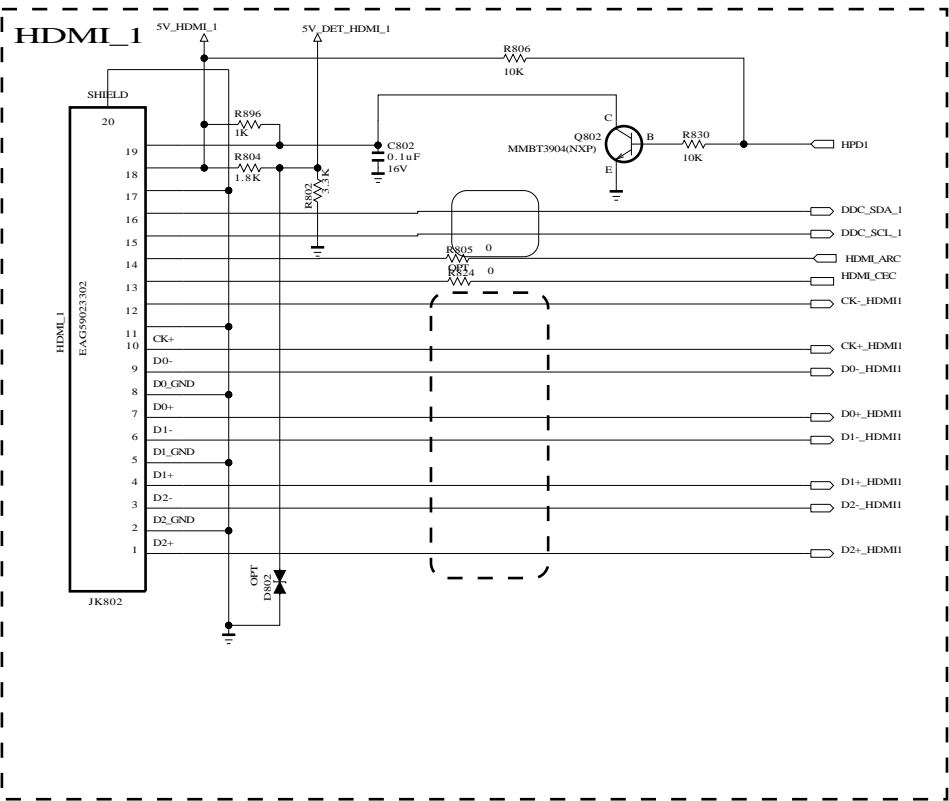
MODEL	GP2R	DATE	20101023
BLOCK	USB_OCP_DIODE	SHEET	7 /

The image displays three circuit diagrams, each showing the connection of an ENKMC2838-T112 component (D821, D822, and D824) to DDC_SCL and DDC_SDA lines. Each diagram includes a 5V_HDMI and +5V_Normal supply, a 0.1uF capacitor (C806, C807, and C809), and 2.7K resistors (R884, R888, R885, R889, R887, and R891).

Diagram 1 (Top): Shows the connection for D821. The ENKMC2838-T112 D821 is connected to 5V_HDMI_1 and +5V_Normal. A 0.1uF capacitor (C806) is connected to the ground pin. The DDC_SCL_1 and DDC_SDA_1 lines are connected to the output pins through 2.7K resistors (R884 and R888).

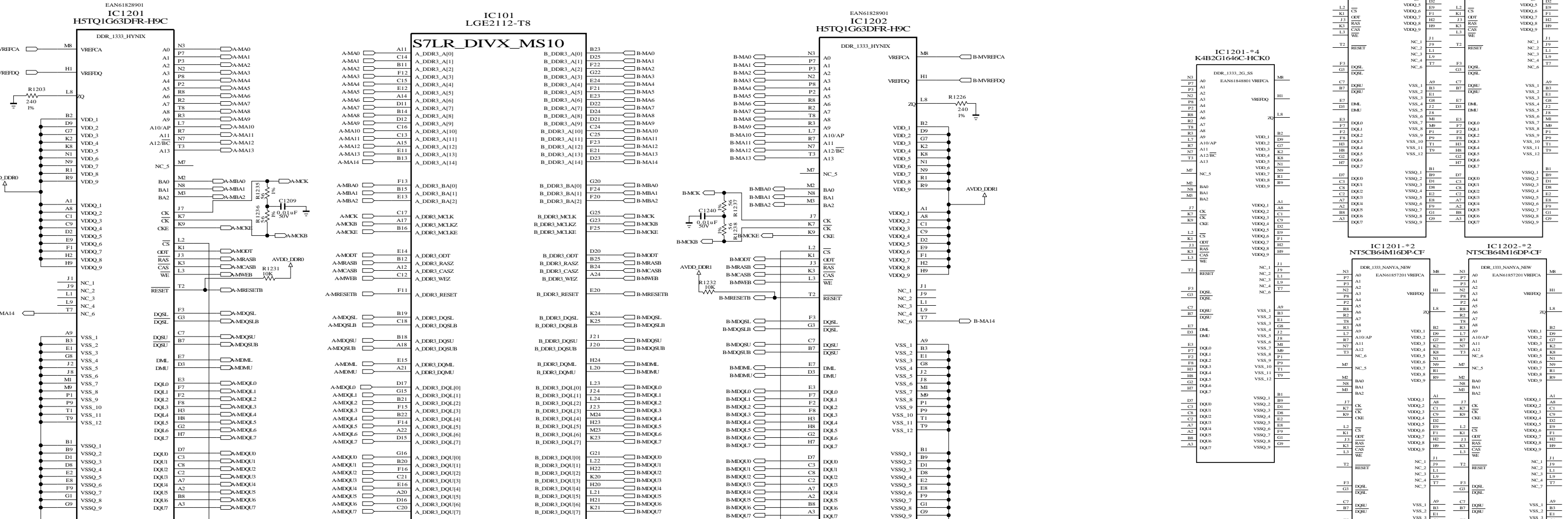
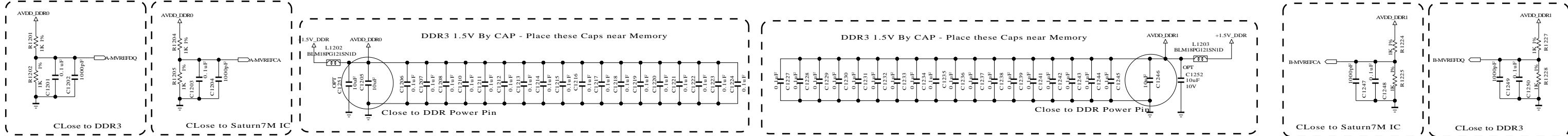
Diagram 2 (Middle): Shows the connection for D822. The ENKMC2838-T112 D822 is connected to 5V_HDMI_2 and +5V_Normal. A 0.1uF capacitor (C807) is connected to the ground pin. The DDC_SCL_2 and DDC_SDA_2 lines are connected to the output pins through 2.7K resistors (R885 and R889).

Diagram 3 (Bottom): Shows the connection for D824. The ENKMC2838-T112 D824 is connected to 5V_HDMI_4 and +5V_Normal. A 0.1uF capacitor (C809) is connected to the ground pin. The DDC_SCL_4 and DDC_SDA_4 lines are connected to the output pins through 2.7K resistors (R887 and R891).



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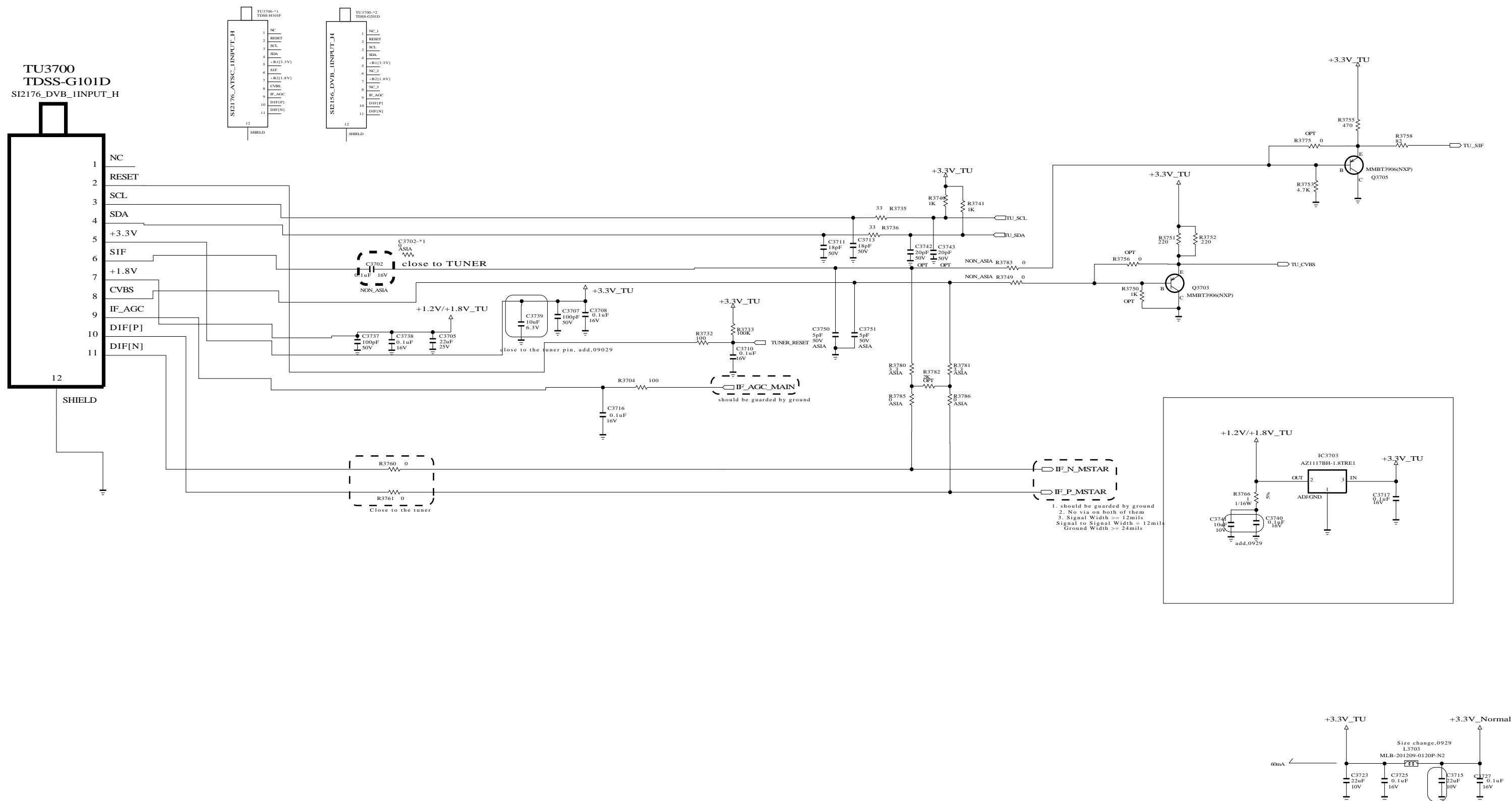
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.



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MODEL	GP3_S7LR	DATE	20110511
BLOCK	DDR_256	SHEET	12 /

P4R_GLOBAL_TUNER_BLOCK

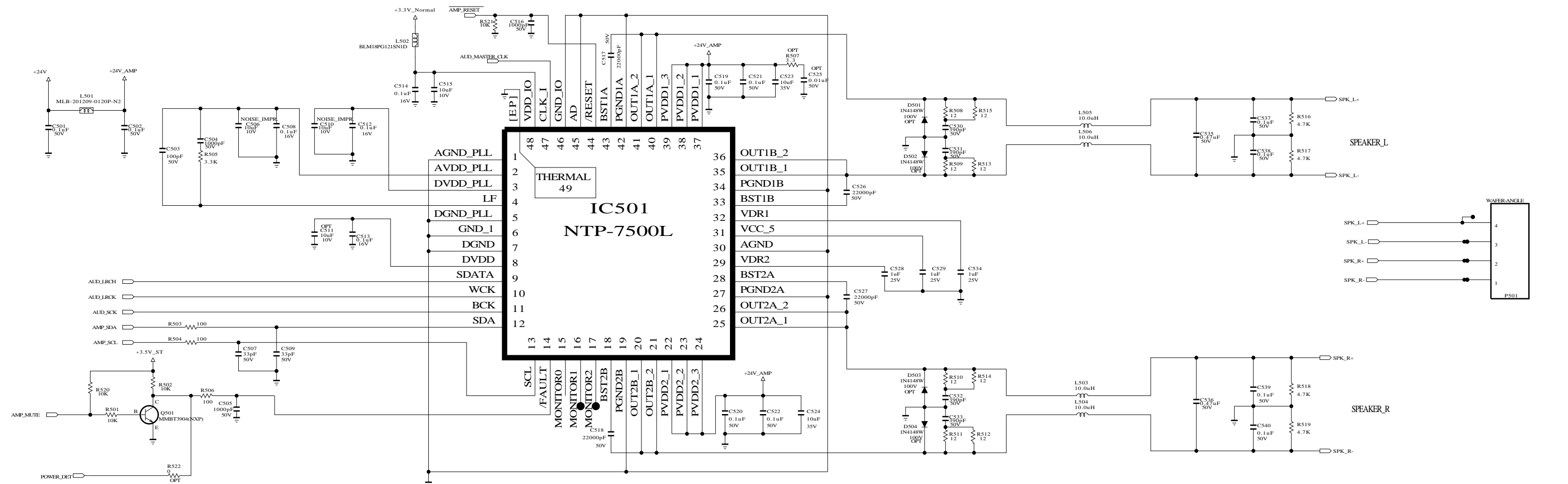




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MODEL	GP3_S7LR	DATE	20110511
BLOCK	TUNER_L	SHEET	14 /

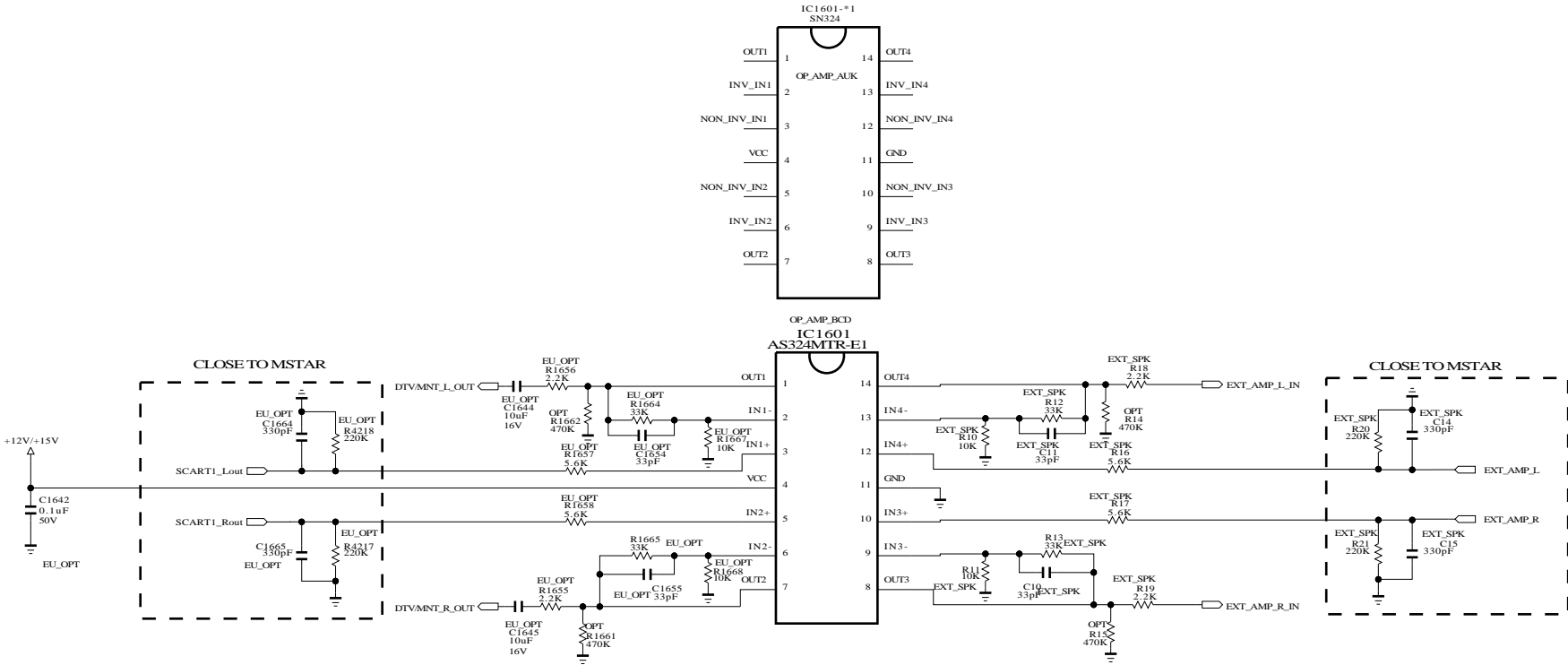
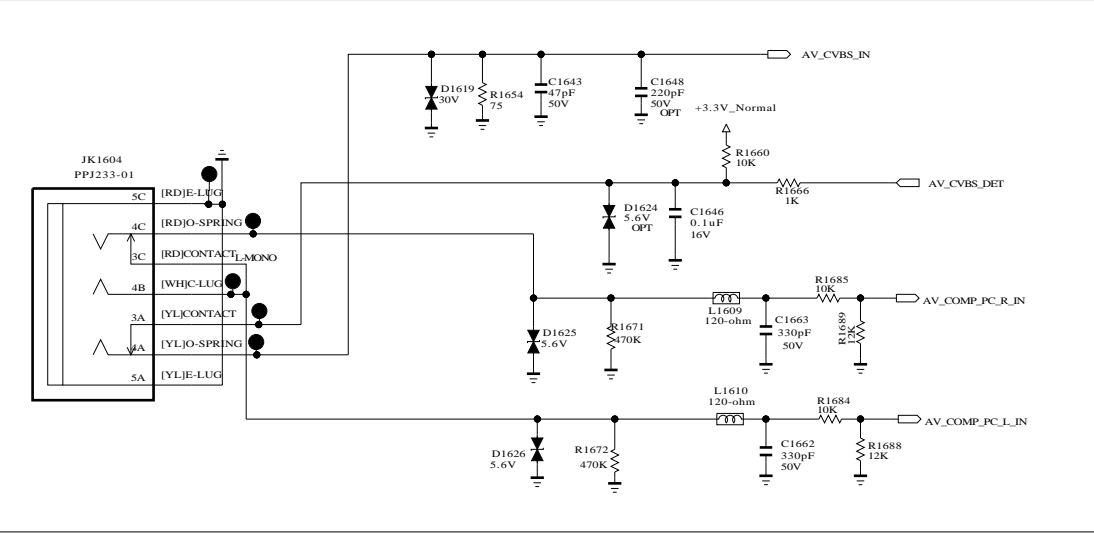


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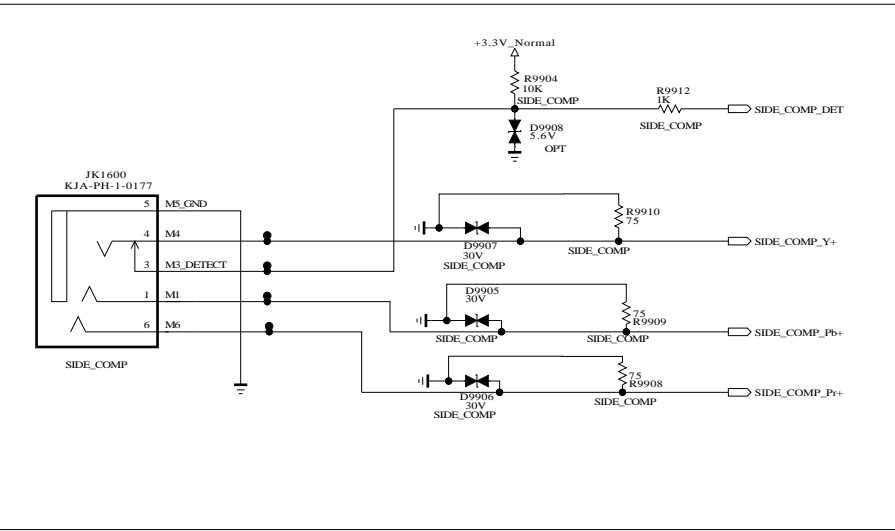
SECRET	 LG ELECTRONICS
LG Electronics	

MODEL	GP3 S7LR	DATE	20110324
BLOCK	NTP7400	SHEET	16 /

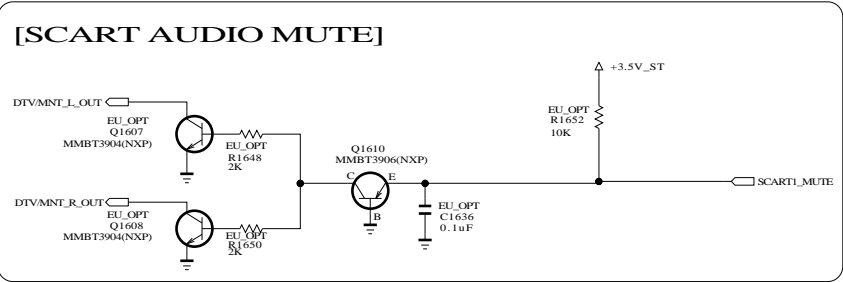
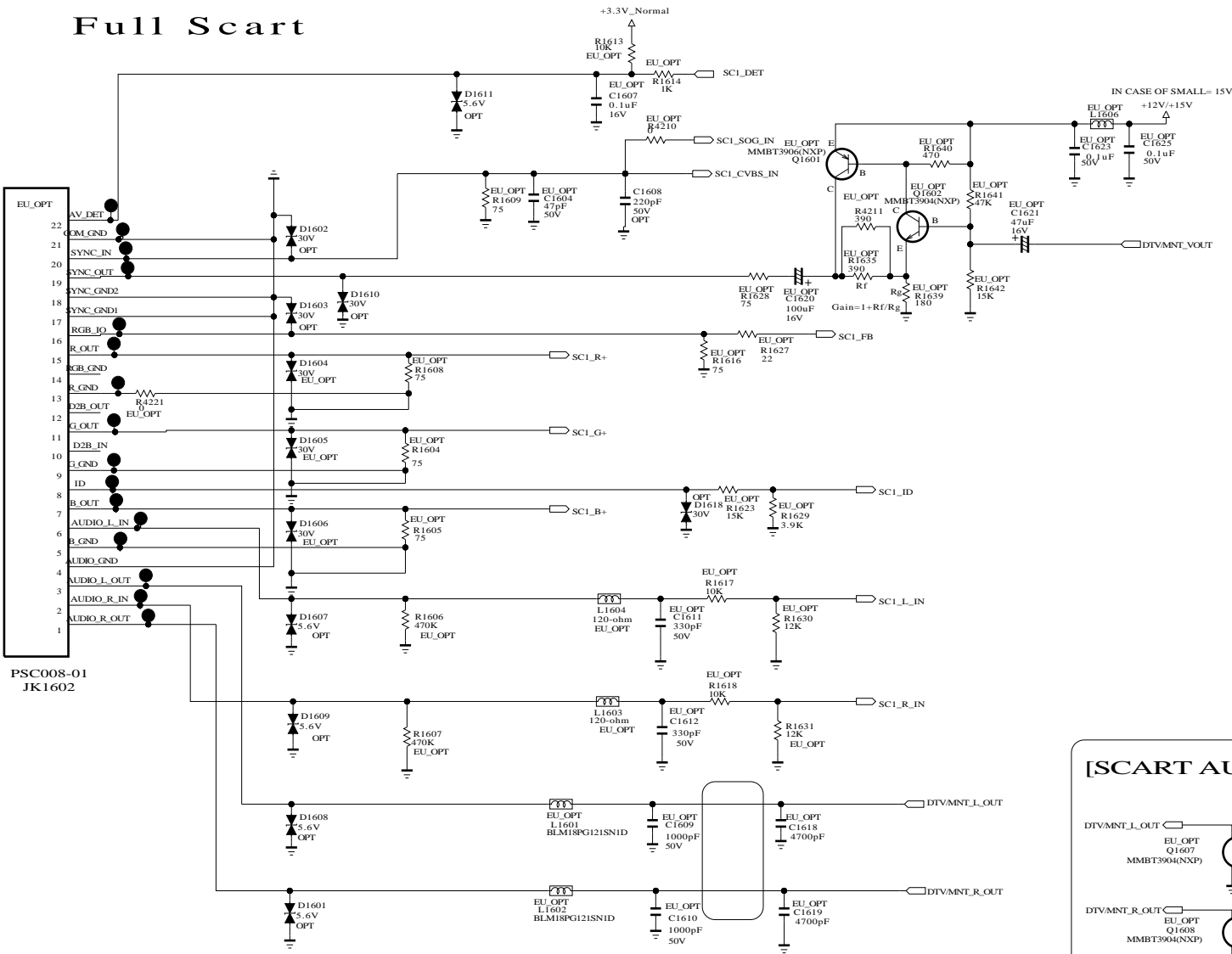
Rear AV



SIDE COMPONENT PHONE JACK



Full Scart



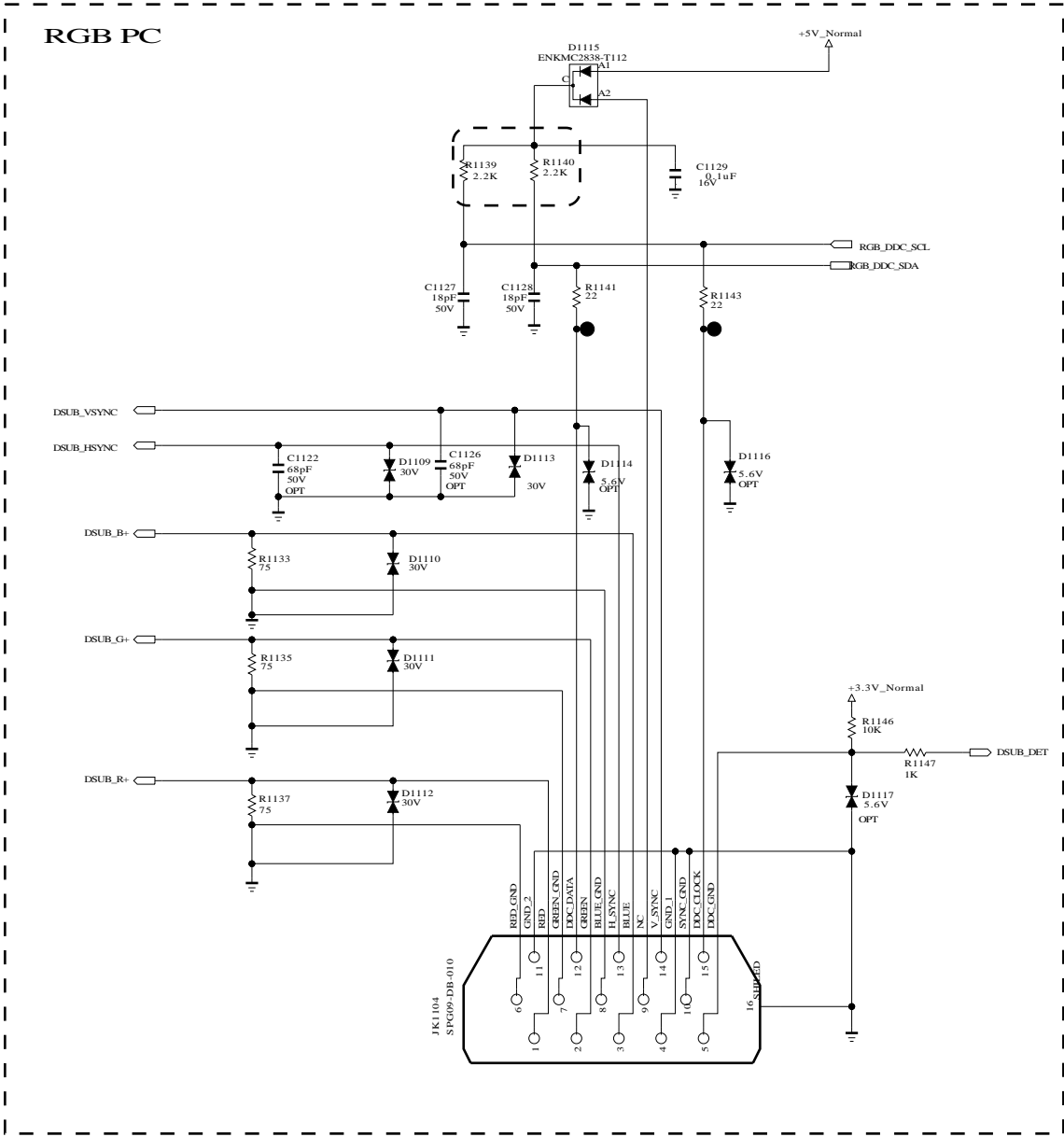
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.



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MODEL	GP3 S7LR	DATE	20110324
BLOCK	REAR JACK	SHEET	17 /

RGB



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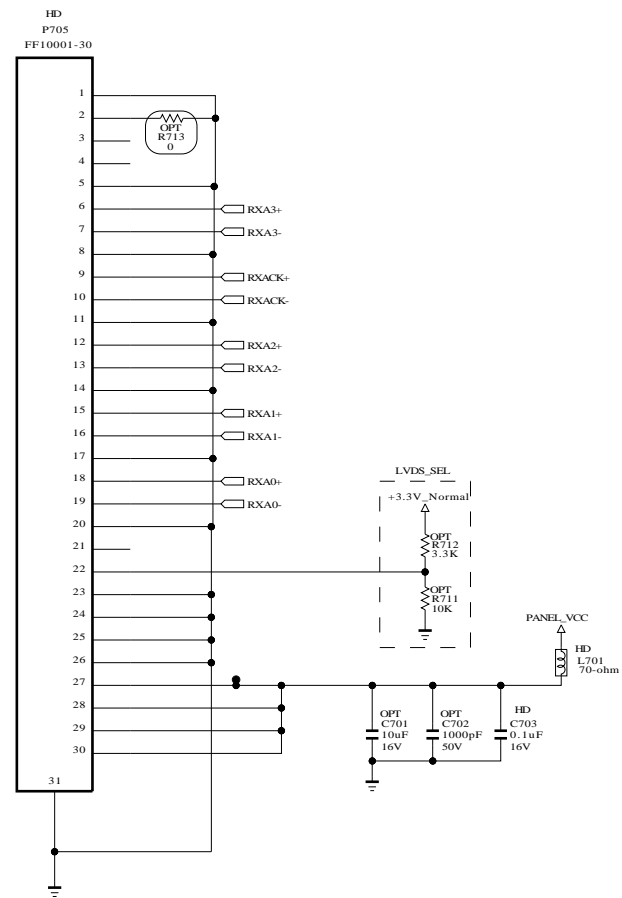




MODEL	GP3_S7LR	DATE	20110324
BLOCK	RGB/SPDIF/HP	SHEET	9 /

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[30Pin LVDS Connector]
(For HD 60Hz_Normal)

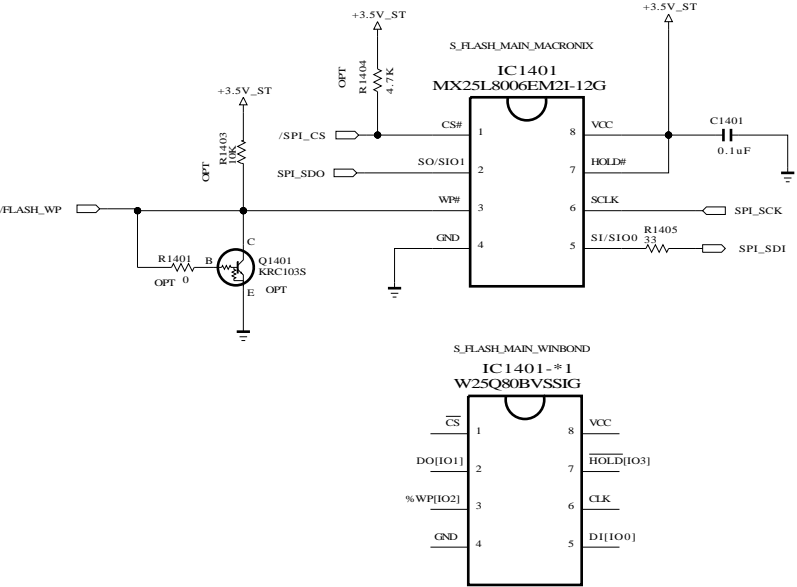




THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMETIC.

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MODEL	GP3_S7LR	DATE	20110324
BLOCK	LVDS_LARGE	SHEET	11 /



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LGElectronics	

MODEL	GP3 S7LR	DATE	20110324
BLOCK	SFLASH	SHEET	13 /

The schematic diagram illustrates the internal circuitry of the RJP JK1800 module. Key components include:

- Power Supply:** A +12V/15V input is connected through a fuse and a resistor network (R1800, R1801, R1803, R1802) to the module's internal power rails.
- Operational Amplifiers:** Two AO3407A RJP operational amplifiers, Q1800 and Q1802, are used for signal processing.
- Resistors and Capacitors:** Various resistors (R1800, R1801, R1803, R1802, R1806, R1804, R1805, R1807, R1854) and capacitors (C1800, C1801, C1803, C1805, C1806, C1807) are used for timing, filtering, and signal conditioning.
- Control Pins:** The module features 5 control pins on the right, labeled RJP_CTRL0, RJP_CTRL1, RJP_CTRL2, RJP_CTRL3, and RJP_CTRL4, each connected to a specific internal circuit.
- Identification:** The module is identified as RJP JK1800 and RJPV9768-1001-024.

The schematic diagram illustrates the TPA6011A4PWPRG4 audio amplifier circuit. The central component is the TPA6011A4PWPRG4 IC, which is configured with various pins connected to external components. The circuit includes a +5V_SUB_AMP supply, a +3.5V_ST supply, and a SUB_AMP_MUTE signal. Key components include resistors R1814, R1813, R1845, R1846, R1847, R1848, R1849, R1850, R1851, R1852, R1853, and R1803; capacitors C1802, C1834, C1835, C1836, and C1837; and a diode Q1805. The circuit is designed to drive external speakers (EXT_SPK) and a sub-amplifier (SUB_AMP).

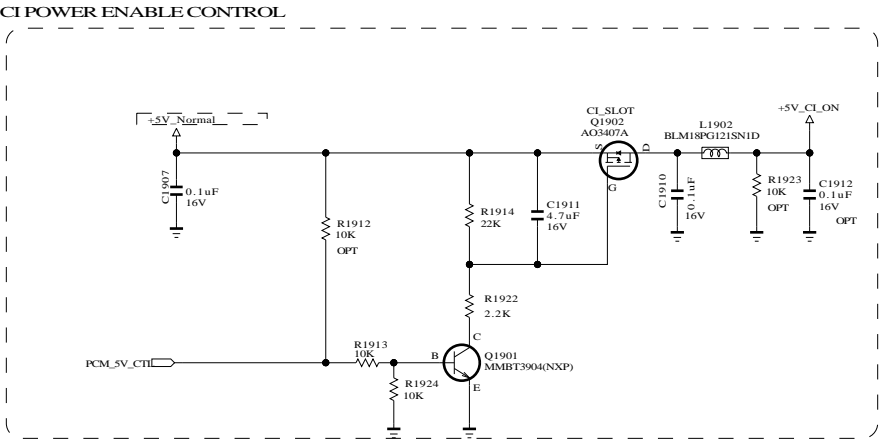
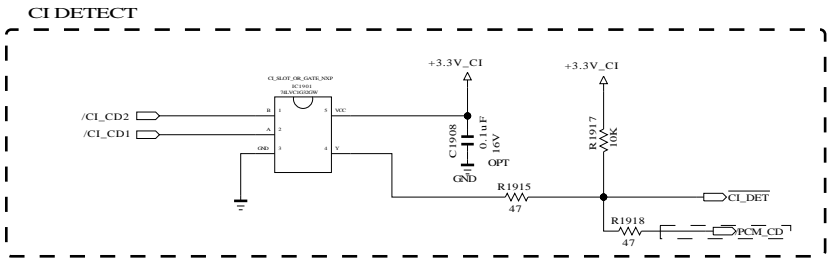
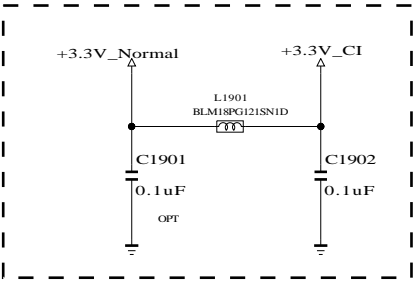
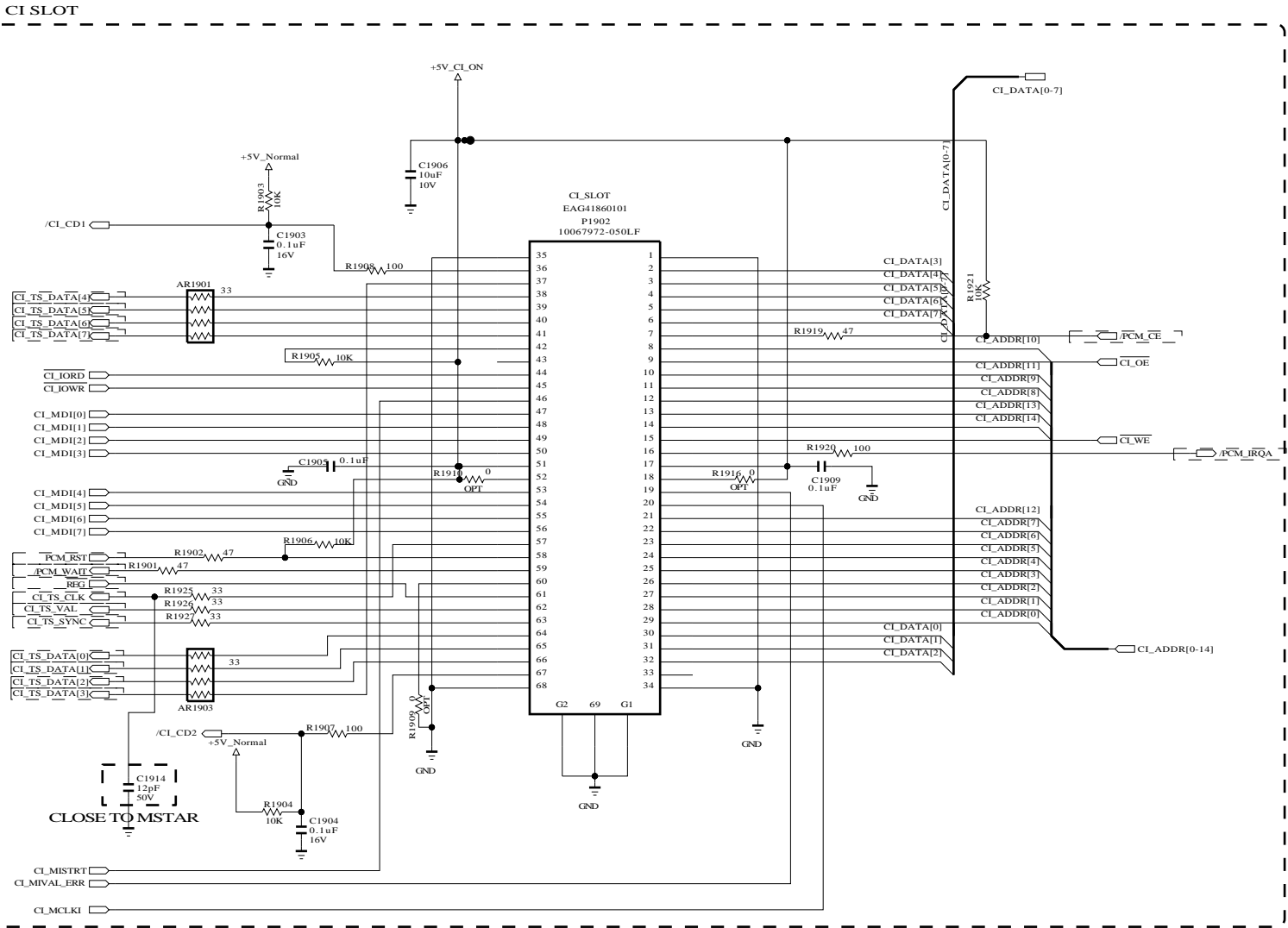
The schematic diagram illustrates the internal circuitry of the PEJ029-02 module, which is a 6-pin connector. The module is labeled with the part number JK1801 and PEJ029-02. The internal components include:

- Input/Output Signals:**
 - EXT_SPK_R+ (3:AF8):** Connected to L1802 EXT_SPK.
 - EXT_SPK_R- (3:AF8):** Connected to L1803 EXT_SPK.
 - EXT_SPK_L+ (3:AF8):** Connected to L1804 EXT_SPK.
 - EXT_SPK_L- (3:AF8):** Connected to L1805 EXT_SPK.
- Internal Components:**
 - Capacitors:** C1812, C1813, C1810, and C1811, all 39pF OPT.
 - Resistors:** R1827 (51K), R1828 (100), R1808 (4.7K).
 - Inductors:** L1802, L1803, L1804, and L1805.
- Power and Ground Connections:**
 - +3.3V_Normal:** Connected to the module via R1827 (51K).
 - EXT_SPK:** Connected to the module via R1828 (100).
 - EXT_SPK_DET:** Connected to the module via R1808 (4.7K).
- Internal Connections:**
 - G_SPRING:** Connected to the module.
 - E_SPRING:** Connected to the module.
 - R_SPRING:** Connected to the module.
 - T_SPRING:** Connected to the module.
 - B_TERMINAL:** Connected to the module.
 - T_TERMINAL:** Connected to the module.

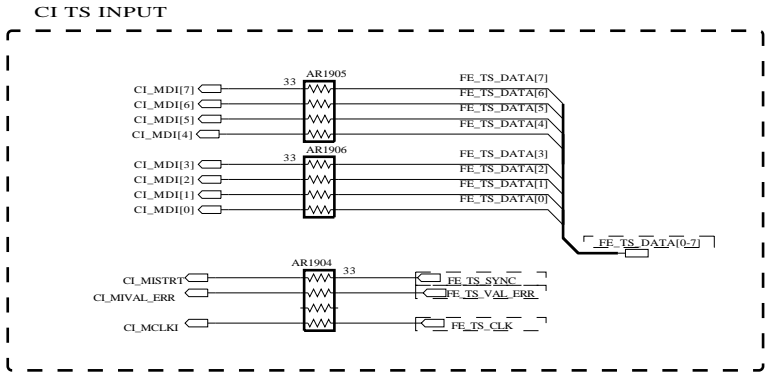
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LGElectronics



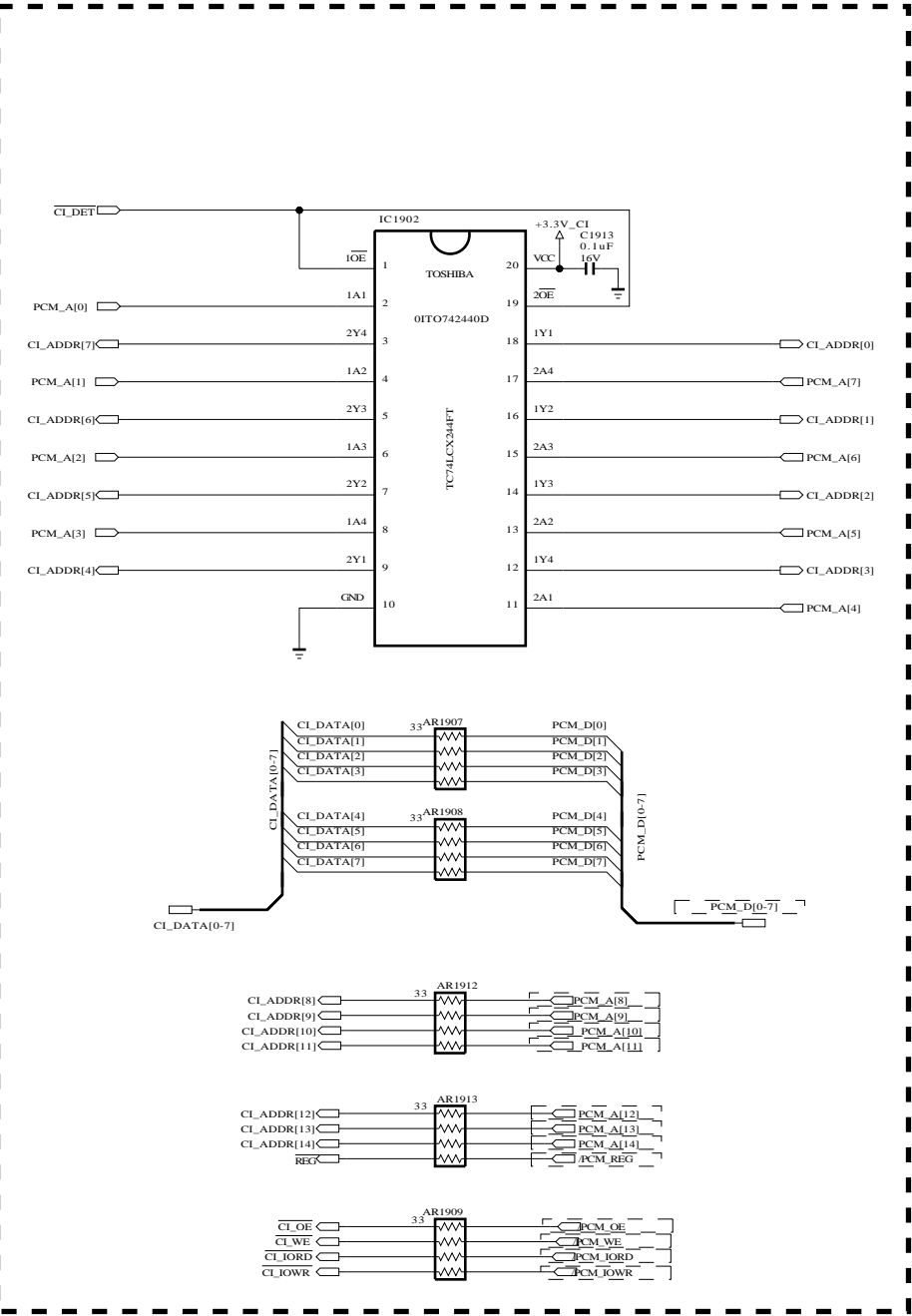
CI Region





* Option name of this page : CI_SLOT
(because of Hong Kong)



CI HOST I/F



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MODEL	GP3_S7LR	DATE	20110324
BLOCK	PCMCi	SHEET	20 /

